



## 3-Channel RGBHV Video Buffer with I<sup>2</sup>C™ Control, 2:1 Input Mux, Monitor Pass-Through, and Selectable Input Bias Modes

Check for Samples: [THS7347](#)

### FEATURES

- 3-Video Amplifiers for CVBS, S-Video, EDTV, HDTV Y'P'B'P'R, G'B'R', and R'G'B' Video
- H/V Sync Paths with Adjustable Schmitt Trigger
- 2:1 Input Mux
- I<sup>2</sup>C Control of All Functions on Each Channel
- Unity-Gain Buffer Path for ADC Buffering:
  - 500-MHz Bandwidth, 1200-V/μs Slew Rate
- Monitor Pass-Through Function:
  - 500-MHz Bandwidth, 1300-V/μs Slew Rate
  - 6-dB Gain with SAG Correction Capable
  - High Output Impedance in Disable State
- Selectable Input Bias Modes:
  - AC-Coupled with Sync-Tip Clamp
  - AC-Coupled with Bias
  - DC-Coupled with Offset Shift
  - DC-Coupled
- +2.7-V to +5-V Single-Supply Operation
- Total Power Consumption: 265 mW at 3.3 V
- Disable Function Reduces Current to 0.1 μA
- Rail-to-Rail Output:
  - Output Swings Within 0.1 V of the Rails, Allowing AC- or DC-Output Coupling
- Lead-free, RoHS TQFP Package

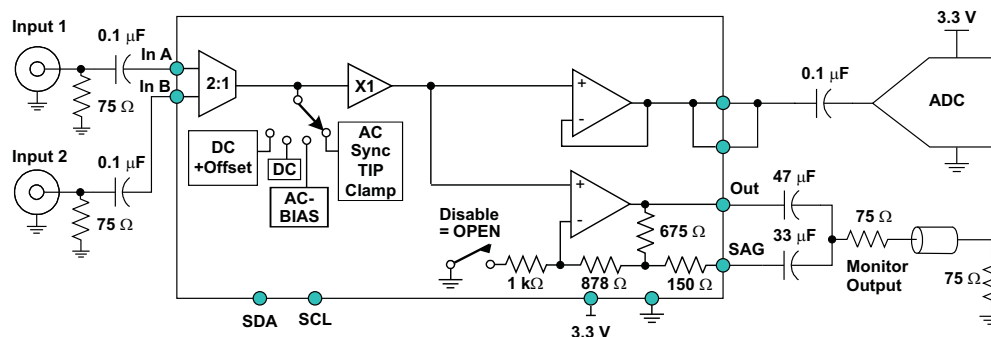
### APPLICATIONS

- Projectors
- Professional Video Systems
- LCD/ DLP®/LOCS Input Buffering

### DESCRIPTION

Fabricated using the revolutionary complimentary silicon-germanium (SiGe) BiCom3 process, the THS7347 is a low-power, single-supply 2.7-V to 5-V 3-channel integrated video buffer with horizontal (H) and vertical (V) sync signal paths. It incorporates a 500-MHz bandwidth, 1200-V/μs unity-gain buffer ideal for driving analog-to-digital converters (ADCs) and video decoders. In parallel with the unity-gain buffer, a monitor pass-through path allows for passing the input signal on to other systems. This path has a 6-dB gain, 500-MHz bandwidth, 1300-V/μs slew rate, SAG correction capability, and high output impedance while disabled.

Each channel of the THS7347 is individually I<sup>2</sup>C-configurable for all functions, including controlling the 2:1 input mux. Its rail-to-rail output stage allows for both ac- and dc-coupling applications.



**3.3 V Single-Supply Projector Input System with Monitor Pass-Through  
(One of Three R'G'B' Channels Shown)**



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PowerPAD is a trademark of Texas Instruments.

DLP is a registered trademark of Texas Instruments.

I<sup>2</sup>C is a trademark of NXP Semiconductors, Inc.

All other trademarks are the property of their respective owners.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of the Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

## DESCRIPTION, CONTINUED

As part of the THS7347 flexibility, the device input can be selected for ac- or dc-coupled inputs. The ac-coupled modes include a sync-tip clamp option for CVBS/Y'/G'B'R' with sync or a fixed bias for the C'/P'\_B'/P'\_R'/R'G'B' channels without sync. The dc input options include a dc input or a dc+Offset shift to allow for a full sync dynamic range at the output with 0-V input.

The THS7347 is available in a lead-free, RoHS-compliant TQFP package.



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### PACKAGING/ORDERING INFORMATION<sup>(1)</sup>

| PACKAGED DEVICES | PACKAGE TYPE       | TRANSPORT MEDIA, QUANTITY |
|------------------|--------------------|---------------------------|
| THS7347IPHP      | HTQFP-48 PowerPAD™ | Tray, 250                 |
| THS7347IPHR      |                    | Tape and Reel, 1000       |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).

### ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Over operating free-air temperature range (unless otherwise noted).

|                                                              |                                                                                          | THS7347                                      | UNIT |
|--------------------------------------------------------------|------------------------------------------------------------------------------------------|----------------------------------------------|------|
| $V_{SS}$                                                     | Supply voltage, GND to $V_A$ or GND to $V_{DD}$                                          | 5.5                                          | V    |
| $V_I$                                                        | Input voltage                                                                            | -0.4 to $V_A$ or $V_{DD}$                    | V    |
| $I_O$                                                        | Continuous output current                                                                | ±80                                          | mA   |
| Continuous power dissipation                                 |                                                                                          | See <a href="#">Dissipation Rating Table</a> |      |
| $T_J$                                                        | Maximum junction temperature, any condition <sup>(2)</sup>                               | +150                                         | °C   |
| $T_J$                                                        | Maximum junction temperature, continuous operation, long term reliability <sup>(3)</sup> | +125                                         | °C   |
| $T_{stg}$                                                    | Storage temperature range                                                                | -65 to +150                                  | °C   |
| Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds |                                                                                          | 300                                          | °C   |
| ESD ratings                                                  | HBM                                                                                      | 1500                                         | V    |
|                                                              | CDM                                                                                      | 1500                                         | V    |
|                                                              | MM                                                                                       | 100                                          | V    |

- (1) Stresses above those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute maximum rated conditions for extended periods may degrade device reliability.
- (2) The absolute maximum junction temperature under any condition is limited by the constraints of the silicon process.
- (3) The absolute maximum junction temperature for continuous operation is limited by the package constraints. Operation above this temperature may result in reduced reliability and/or lifetime of the device.

### DISSIPATION RATINGS

| PACKAGE                      | $\theta_{JC}$<br>(°C/W) | $\theta_{JA}$<br>(°C/W) | POWER RATING <sup>(1) (2)</sup><br>( $T_J = +125^\circ\text{C}$ ) |                           |
|------------------------------|-------------------------|-------------------------|-------------------------------------------------------------------|---------------------------|
|                              |                         |                         | $T_A = +25^\circ\text{C}$                                         | $T_A = +85^\circ\text{C}$ |
| HTQFP-48 with PowerPAD (PHP) | 1.2                     | 35                      | 2.85 W                                                            | 1.14 W                    |

- (1) This data was taken with a PowerPAD standard 3-inch by 3-inch, 4-layer printed circuit board (PCB) with internal ground plane connections to the PowerPAD.
- (2) Power rating is determined with a junction temperature of +125°C. This temperature is the point where distortion starts to substantially increase and long-term reliability starts to be reduced. Thermal management of the final PCB should strive to keep the junction temperature at or below +125°C for best performance and reliability.

## RECOMMENDED OPERATING CONDITIONS

|                 |                                                                         | MIN             | NOM | MAX | UNIT |
|-----------------|-------------------------------------------------------------------------|-----------------|-----|-----|------|
| V <sub>DD</sub> | Digital supply voltage                                                  | 2.7             |     | 5   | V    |
| V <sub>A</sub>  | Analog supply voltage. Must be equal to or greater than V <sub>DD</sub> | V <sub>DD</sub> |     | 5   | V    |
| T <sub>A</sub>  | Ambient temperature                                                     | –40             |     | +85 | °C   |

## ELECTRICAL CHARACTERISTICS, V<sub>A</sub> = V<sub>DD</sub> = 3.3 V

R<sub>L</sub> = 150 Ω || 5 pF to GND for Monitor Output, 19 kΩ || 8 pF Load to GND for Buffer Output, SAG pin shorted to Monitor Output Pin, unless otherwise noted.

| PARAMETER                           |                | TEST CONDITIONS                                     | TYP       | OVER TEMPERATURE |              |                |         |              |
|-------------------------------------|----------------|-----------------------------------------------------|-----------|------------------|--------------|----------------|---------|--------------|
|                                     |                |                                                     | +25°C     | +25°C            | 0°C to +70°C | –40°C to +85°C | UNIT    | MIN/MAX/ TYP |
| AC PERFORMANCE                      |                |                                                     |           |                  |              |                |         |              |
| Small-signal bandwidth (–3 dB)      | Buffer output  | V <sub>O</sub> = 0.2 V <sub>PP</sub>                | 500       |                  |              |                | MHz     | Typ          |
|                                     | Monitor output |                                                     | 450       |                  |              | MHz            | Typ     |              |
| –1 dB flatness                      | Buffer output  | V <sub>O</sub> = 0.2 V <sub>PP</sub>                | 425       |                  |              |                | MHz     | Typ          |
|                                     | Monitor output |                                                     | 375       |                  |              | MHz            | Typ     |              |
| Large-signal bandwidth (–3 dB)      | Buffer output  | V <sub>O</sub> = 1 V <sub>PP</sub>                  | 475       |                  |              |                | MHz     | Typ          |
|                                     | Monitor output | V <sub>O</sub> = 2 V <sub>PP</sub>                  | 240       |                  |              |                | MHz     | Typ          |
| Slew rate                           | Buffer output  | V <sub>O</sub> = 1 V <sub>PP</sub>                  | 1050      |                  |              |                | V/μs    | Typ          |
|                                     | Monitor output | V <sub>O</sub> = 2 V <sub>PP</sub>                  | 1050      |                  |              |                | V/μs    | Typ          |
| Group delay at 100 kHz              | Buffer output  |                                                     | 1.2       |                  |              |                | ns      | Typ          |
|                                     | Monitor output |                                                     | 1.2       |                  |              |                | ns      | Typ          |
| Differential gain                   | Buffer output  | NTSC/PAL                                            | 0.05/0.05 |                  |              |                | %       | Typ          |
|                                     | Monitor output |                                                     | 0.1/0.1   |                  |              | %              | Typ     |              |
| Differential phase                  | Buffer output  | NTSC/PAL                                            | 0.1/0.15  |                  |              |                | degrees | Typ          |
|                                     | Monitor output |                                                     | 0.15/0.2  |                  |              | degrees        | Typ     |              |
| Total harmonic distortion f = 1 MHz | Buffer output  | V <sub>O</sub> = 1 V <sub>PP</sub>                  | –58       |                  |              |                | dB      | Typ          |
|                                     | Monitor output | V <sub>O</sub> = 2 V <sub>PP</sub>                  | –57       |                  |              |                | dB      | Typ          |
| Signal-to-noise ratio               | Buffer output  | No weighting, up to 100 MHz                         | 63        |                  |              |                | dB      | Typ          |
|                                     | Monitor output |                                                     | 65        |                  |              |                | dB      | Typ          |
| Channel-to-channel crosstalk        | Buffer output  | f = 100 MHz                                         | –40       |                  |              |                | dB      | Typ          |
|                                     | Monitor output |                                                     | –36       |                  |              |                | dB      | Typ          |
| MUX isolation                       | Buffer output  | f = 100 MHz                                         | 64        |                  |              |                | dB      | Typ          |
|                                     | Monitor output |                                                     | 66        |                  |              |                | dB      | Typ          |
| Gain                                | Buffer output  | f = 100 kHz; V <sub>O</sub> = 1 V <sub>PP</sub>     | 0         |                  |              |                | dB      | Typ          |
|                                     | Monitor output | f = 100 kHz; V <sub>O</sub> = 2 V <sub>PP</sub>     | 6         | 5.8/6.25         | 5.75/6.3     | 5.75/6.35      | dB      | Min/Max      |
| Settling time                       | Buffer output  | V <sub>IN</sub> = 1 V <sub>PP</sub> ; 0.5% settling | 6         |                  |              |                | ns      | Typ          |
|                                     | Monitor output |                                                     | 6         |                  |              |                | ns      | Typ          |
| Output impedance                    | Buffer output  | f = 10 MHz                                          | 0.3       |                  |              |                | Ω       | Typ          |
|                                     | Monitor output |                                                     | 0.4       |                  |              |                | Ω       | Typ          |
| DC PERFORMANCE                      |                |                                                     |           |                  |              |                |         |              |
| Output offset voltage               | Buffer output  | Bias = dc                                           | 15        | ±80              | ±85          | ±85            | mV      | Max          |
|                                     | Monitor output |                                                     | 20        | ±120             | ±125         | ±125           | mV      | Max          |
| Average offset voltage drift        | Buffer output  | Bias = dc                                           |           |                  |              | 20             | μV/°C   | Typ          |
|                                     | Monitor output |                                                     |           |                  |              | 20             | μV/°C   | Typ          |
| Bias output voltage                 | Buffer output  | Bias = dc + shift, V <sub>IN</sub> = 0 V            | 255       | 175/355          | 165/365      | 160/370        | mV      | Min/Max      |
|                                     |                | Bias = ac                                           | 1.0       | 0.85/1.15        | 0.8/1.2      | 0.8/1.2        | V       | Min/Max      |
|                                     | Monitor output | Bias = dc + shift, V <sub>IN</sub> = 0 V            | 235       | 145/350          | 135/360      | 130/365        | mV      | Min/Max      |
|                                     |                | Bias = ac                                           | 1.7       | 1.55/1.85        | 1.5/1.9      | 1.5/1.9        | V       | Min/Max      |
| Sync tip clamp voltage              | Buffer output  | Bias = ac STC, clamp voltage                        | 290       | 200/405          | 195/410      | 190/415        | mV      | Min/Max      |
|                                     | Monitor output |                                                     | 300       | 200/400          | 195/405      | 190/410        | mV      | Min/Max      |

**ELECTRICAL CHARACTERISTICS,  $V_A = V_{DD} = 3.3\text{ V}$  (continued)**

$R_L = 150\ \Omega \parallel 5\text{ pF}$  to GND for Monitor Output,  $19\text{ k}\Omega \parallel 8\text{ pF}$  Load to GND for Buffer Output, SAG pin shorted to Monitor Output Pin, unless otherwise noted.

| PARAMETER                                                          |          | TEST CONDITIONS                                                                                    | TYP    | OVER TEMPERATURE |                 |                   |       | MIN/MAX/<br>TYP |
|--------------------------------------------------------------------|----------|----------------------------------------------------------------------------------------------------|--------|------------------|-----------------|-------------------|-------|-----------------|
|                                                                    |          |                                                                                                    | +25°C  | +25°C            | 0°C to<br>+70°C | –40°C to<br>+85°C | UNIT  |                 |
| DC PERFORMANCE, continued                                          |          |                                                                                                    |        |                  |                 |                   |       |                 |
| Input bias current                                                 |          | Bias = dc; (–) implies I <sub>B</sub> out of the pin                                               | –1.3   | –3.0             | –3.5            | –3.5              | μA    | Max             |
| Average bias current drift                                         |          | Bias = dc                                                                                          |        |                  |                 | 10                | nA/°C | Typ             |
| Sync tip clamp bias current                                        |          | Bias = ac STC, low bias                                                                            | 2.3    | 0.9/3.6          | 0.8/3.8         | 0.7/3.9           | μA    | Min/Max         |
|                                                                    |          | Bias = ac STC, mid bias                                                                            | 5.8    | 3.8/8.0          | 3.7/8.2         | 3.6/8.3           | μA    | Min/Max         |
|                                                                    |          | Bias = ac STC, high bias                                                                           | 8.1    | 5.7/10.8         | 5.6/11.0        | 5.5/11.1          | μA    | Min/Max         |
| INPUT CHARACTERISTICS                                              |          |                                                                                                    |        |                  |                 |                   |       |                 |
| Input voltage range                                                |          | Bias = dc                                                                                          | 0 to 2 |                  |                 |                   | V     | Typ             |
| Input resistance                                                   |          | Bias = ac bias mode                                                                                | 25     |                  |                 |                   | kΩ    | Typ             |
|                                                                    |          | Bias = dc, dc + shift, ac STC                                                                      | 3      |                  |                 |                   | MΩ    | Typ             |
| Input capacitance                                                  |          |                                                                                                    | 1.5    |                  |                 |                   | pF    | Typ             |
| OUTPUT CHARACTERISTICS: MONITOR OUTPUT                             |          |                                                                                                    |        |                  |                 |                   |       |                 |
| High output voltage swing                                          |          | R <sub>L</sub> = 150 Ω to 1.65 V                                                                   | 3.15   | 2.9              | 2.8             | 2.8               | V     | Min             |
|                                                                    |          | R <sub>L</sub> = 150 Ω to GND                                                                      | 3.05   | 2.85             | 2.75            | 2.75              | V     | Min             |
|                                                                    |          | R <sub>L</sub> = 75 Ω to 1.65 V                                                                    | 3.05   |                  |                 |                   | V     | Typ             |
|                                                                    |          | R <sub>L</sub> = 75 Ω to GND                                                                       | 2.9    |                  |                 |                   | V     | Typ             |
| Low output voltage swing                                           |          | R <sub>L</sub> = 150 Ω to 1.65 V                                                                   | 0.15   | 0.25             | 0.28            | 0.29              | V     | Max             |
|                                                                    |          | R <sub>L</sub> = 150 Ω to GND                                                                      | 0.1    | 0.18             | 0.21            | 0.22              | V     | Max             |
|                                                                    |          | R <sub>L</sub> = 75 Ω to 1.65 V                                                                    | 0.25   |                  |                 |                   | V     | Typ             |
|                                                                    |          | R <sub>L</sub> = 75 Ω to GND                                                                       | 0.08   |                  |                 |                   | V     | Typ             |
| Output current                                                     | Sourcing | R <sub>L</sub> = 10 Ω to 1.65 V                                                                    | 80     | 50               | 47              | 45                | mA    | Min             |
|                                                                    | Sinking  |                                                                                                    | 75     | 50               | 47              | 45                | mA    | Min             |
| OUTPUT CHARACTERISTICS: BUFFER OUTPUT                              |          |                                                                                                    |        |                  |                 |                   |       |                 |
| High output voltage swing<br>(Limited by input range and G = 0 dB) |          | Load = 19 kΩ    8 pF to 1.65 V                                                                     | 2      | 1.8              | 1.75            | 1.75              | V     | Min             |
| Low Output voltage swing<br>(Limited by input range and G = 0 dB)  |          |                                                                                                    | 0.05   | 0.12             | 0.13            | 0.14              | V     | Max             |
| Output Current                                                     | Sourcing | R <sub>L</sub> = 10 Ω to GND                                                                       | 80     | 50               | 47              | 45                | mA    | Min             |
|                                                                    | Sinking  | R <sub>L</sub> = 10 Ω to 1.65 V                                                                    | 75     | 50               | 47              | 45                | mA    | Min             |
| POWER SUPPLY: ANALOG                                               |          |                                                                                                    |        |                  |                 |                   |       |                 |
| Maximum operating voltage                                          |          | V <sub>A</sub>                                                                                     | 3.3    | 5.5              | 5.5             | 5.5               | V     | Max             |
| Minimum operating voltage                                          |          | V <sub>A</sub>                                                                                     | 3.3    | 2.7              | 2.7             | 2.7               | V     | Min             |
| Maximum quiescent current                                          |          | V <sub>A</sub> , dc + shift mode, V <sub>IN</sub> = 100 mV                                         | 80     | 100              | 103             | 105               | mA    | Max             |
| Minimum quiescent current                                          |          | V <sub>A</sub> , dc + shift mode, V <sub>IN</sub> = 100 mV                                         | 80     | 60               | 57              | 55                | mA    | Min             |
| Power supply rejection (+PSRR)                                     |          | Buffer output                                                                                      | 50     |                  |                 |                   | dB    | Typ             |
| POWER SUPPLY: DIGITAL                                              |          |                                                                                                    |        |                  |                 |                   |       |                 |
| Maximum operating voltage                                          |          | V <sub>DD</sub>                                                                                    | 3.3    | 5.5              | 5.5             | 5.5               | V     | Max             |
| Minimum operating voltage                                          |          | V <sub>DD</sub>                                                                                    | 3.3    | 2.7              | 2.7             | 2.7               | V     | Min             |
| Maximum quiescent current                                          |          | V <sub>DD</sub> , V <sub>IN</sub> = 0 V                                                            | 0.65   | 1.2              | 1.3             | 1.4               | mA    | Max             |
| Minimum quiescent current                                          |          | V <sub>DD</sub> , V <sub>IN</sub> = 0 V                                                            | 0.65   | 0.35             | 0.3             | 0.25              | mA    | Min             |
| DISABLE CHARACTERISTICS: ALL CHANNELS DISABLED                     |          |                                                                                                    |        |                  |                 |                   |       |                 |
| Quiescent current                                                  |          | All channels disabled                                                                              | 0.1    |                  |                 |                   | μA    | Typ             |
| Turn-on time delay (t <sub>ON</sub> )                              |          | Time for I <sub>S</sub> to reach 50% of final value<br>after I <sup>2</sup> C control is initiated | 5      |                  |                 |                   | μs    | Typ             |
| Turn-on time delay (t <sub>OFF</sub> )                             |          |                                                                                                    | 2      |                  |                 |                   | μs    | Typ             |

**ELECTRICAL CHARACTERISTICS,  $V_A = V_{DD} = 3.3\text{ V}$  (continued)**

$R_L = 150\ \Omega \parallel 5\text{ pF}$  to GND for Monitor Output,  $19\text{ k}\Omega \parallel 8\text{ pF}$  Load to GND for Buffer Output, SAG pin shorted to Monitor Output Pin, unless otherwise noted.

| PARAMETER                                                                | TEST CONDITIONS                                                              | TYP      | OVER TEMPERATURE |              |                |      |                 |
|--------------------------------------------------------------------------|------------------------------------------------------------------------------|----------|------------------|--------------|----------------|------|-----------------|
|                                                                          |                                                                              | +25°C    | +25°C            | 0°C to +70°C | −40°C to +85°C | UNIT | MIN/MAX/<br>TYP |
| DIGITAL CHARACTERISTICS <sup>(1)</sup>                                   |                                                                              |          |                  |              |                |      |                 |
| High level input voltage                                                 | V <sub>IH</sub>                                                              | 2.3      |                  |              |                | V    | Typ             |
| Low level input voltage                                                  | V <sub>IL</sub>                                                              | 1.0      |                  |              |                | V    | Typ             |
| H/V SYNC CHARACTERISTICS: R <sub>Load</sub> = 1 kΩ To GND <sup>(2)</sup> |                                                                              |          |                  |              |                |      |                 |
| Schmitt trigger adjust pin voltage                                       | Reference for Schmitt trigger                                                | 1.47     | 1.35/1.6         | 1.3/1.65     | 1.27/1.68      | V    | Min/Max         |
| Schmitt trigger threshold range                                          | Allowable range for Schmitt trigger adjust                                   | 0.9 to 2 |                  |              |                | V    | Typ             |
| Schmitt trigger VT+                                                      | Positive-going input voltage threshold relative to Schmitt trigger threshold | 0.25     |                  |              |                | V    | Typ             |
| Schmitt trigger VT−                                                      | Negative-going input voltage threshold relative to Schmitt trigger threshold | −0.3     |                  |              |                | V    | Typ             |
| Schmitt trigger threshold pin input resistance                           | Input resistance into Control pin                                            | 10       |                  |              |                | kΩ   | Typ             |
| H/V Sync input impedance                                                 |                                                                              | 10       |                  |              |                | MΩ   | Typ             |
| H/V Sync high output voltage                                             | 1 kΩ to GND                                                                  | 3.15     | 3.05             | 3.0          | 3.0            | V    | Min             |
| H/V Sync low output voltage                                              | 1 kΩ to GND                                                                  | 0.01     | 0.05             | 0.1          | 0.1            | V    | Max             |
| H/V Sync source current                                                  | 10 Ω to GND                                                                  | 50       | 35               | 30           | 30             | mA   | Min             |
| H/V Sync sink current                                                    | 10 Ω to 3.3 V                                                                | 35       | 25               | 23           | 21             | mA   | Min             |
| H/V Delay                                                                | Delay from Input to output                                                   | 6.5      |                  |              |                | ns   | Typ             |
| H/V to buffer output skew                                                |                                                                              | 5        |                  |              |                | ns   | Typ             |

(1) Standard CMOS logic.

(2) Schmitt trigger threshold is defined by  $(VT+ - VT-)/2$ .

**ELECTRICAL CHARACTERISTICS,  $V_A = V_{DD} = 5\text{ V}$** 

$R_L = 150\Omega \parallel 5\text{pF}$  to GND for Monitor Output,  $19\text{k}\Omega \parallel 8\text{pF}$  Load to GND for Buffer Output, SAG pin shorted to Monitor Output Pin, unless otherwise noted.

| PARAMETER                           |                | TEST CONDITIONS                                      | TYP       | OVER TEMPERATURE |              |                |         |                 |
|-------------------------------------|----------------|------------------------------------------------------|-----------|------------------|--------------|----------------|---------|-----------------|
|                                     |                |                                                      | +25°C     | +25°C            | 0°C to +70°C | –40°C to +85°C | UNIT    | MIN/MAX/<br>TYP |
| AC PERFORMANCE                      |                |                                                      |           |                  |              |                |         |                 |
| Small-signal bandwidth (–3 dB)      | Buffer output  | V <sub>O</sub> = 0.2 V <sub>PP</sub>                 | 550       |                  |              |                | MHz     | Typ             |
|                                     | Monitor output |                                                      | 500       |                  |              |                | MHz     | Typ             |
| –1 dB flatness                      | Buffer output  | V <sub>O</sub> = 0.2 V <sub>PP</sub>                 | 450       |                  |              |                | MHz     | Typ             |
|                                     | Monitor output |                                                      | 400       |                  |              |                | MHz     | Typ             |
| Large-signal bandwidth (–3 dB)      | Buffer output  | V <sub>O</sub> = 1 V <sub>PP</sub>                   | 525       |                  |              |                | MHz     | Typ             |
|                                     | Monitor output | V <sub>O</sub> = 2 V <sub>PP</sub>                   | 325       |                  |              |                | MHz     | Typ             |
| Slew rate                           | Buffer output  | V <sub>O</sub> = 1 V <sub>PP</sub>                   | 1200      |                  |              |                | V/μs    | Typ             |
|                                     | Monitor output | V <sub>O</sub> = 2 V <sub>PP</sub>                   | 1350      |                  |              |                | V/μs    | Typ             |
| Group delay at 100 kHz              | Buffer output  |                                                      | 1.15      |                  |              |                | ns      | Typ             |
|                                     | Monitor output |                                                      | 1.15      |                  |              |                | ns      | Typ             |
| Differential gain                   | Buffer output  | NTSC/PAL                                             | 0.05/0.05 |                  |              |                | %       | Typ             |
|                                     | Monitor output |                                                      | 0.1/0.1   |                  |              |                | %       | Typ             |
| Differential phase                  | Buffer output  | NTSC/PAL                                             | 0.05/0.05 |                  |              |                | degrees | Typ             |
|                                     | Monitor output |                                                      | 0.05/0.05 |                  |              |                | degrees | Typ             |
| Total harmonic distortion f = 1 MHz | Buffer output  | V <sub>O</sub> = 1 V <sub>PP</sub>                   | –71       |                  |              |                | dB      | Typ             |
|                                     | Monitor output | V <sub>O</sub> = 2 V <sub>PP</sub>                   | –67       |                  |              |                | dB      | Typ             |
| Signal-to-noise ratio               | Buffer output  | No weighting, up to 100 MHz                          | 63        |                  |              |                | dB      | Typ             |
|                                     | Monitor output |                                                      | 65        |                  |              |                | dB      | Typ             |
| Channel-to-channel crosstalk        | Buffer output  | f = 100 MHz                                          | –40       |                  |              |                | dB      | Typ             |
|                                     | Monitor output |                                                      | –36       |                  |              |                | dB      | Typ             |
| MUX Isolation                       | Buffer output  | f = 100 MHz                                          | 64        |                  |              |                | dB      | Typ             |
|                                     | Monitor output |                                                      | 66        |                  |              |                | dB      | Typ             |
| Gain                                | Buffer output  | f = 100 kHz; V <sub>O</sub> = 1 V <sub>PP</sub>      | 0         |                  |              |                | dB      | Typ             |
|                                     | Monitor output | f = 100 kHz; V <sub>O</sub> = 2 V <sub>PP</sub>      | 6         | 5.8/6.25         | 5.75/6.3     | 5.75/6.35      | dB      | Min/Max         |
| Settling time                       | Buffer output  | V <sub>IN</sub> = 1 V <sub>PP</sub> ; 0.5% settling  | 6         |                  |              |                | ns      | Typ             |
|                                     | Monitor output |                                                      | 6         |                  |              |                | ns      | Typ             |
| Output impedance                    | Buffer output  | f = 10 MHz                                           | 0.3       |                  |              |                | Ω       | Typ             |
|                                     | Monitor output |                                                      | 0.4       |                  |              |                | Ω       | Typ             |
| DC PERFORMANCE                      |                |                                                      |           |                  |              |                |         |                 |
| Output offset voltage               | Buffer output  | Bias = dc                                            | 15        | ±80              | ±85          | ±85            | mV      | Max             |
|                                     | Monitor output |                                                      | 20        | ±120             | ±125         | ±125           | mV      | Max             |
| Average offset voltage drift        | Buffer output  | Bias = dc                                            |           |                  |              | 20             | μV/°C   | Typ             |
|                                     | Monitor output |                                                      |           |                  |              | 20             | μV/°C   | Typ             |
| Bias output voltage                 | Buffer output  | Bias = dc + shift, V <sub>IN</sub> = 0 V             | 265       | 185/370          | 175/380      | 170/385        | mV      | Min/Max         |
|                                     |                | Bias = ac                                            | 1.5       | 1.3/1.65         | 1.25/1.7     | 1.25/1.7       | V       | Min/Max         |
|                                     | Monitor output | Bias = dc + shift, V <sub>IN</sub> = 0 V             | 235       | 145/345          | 135/355      | 130/360        | mV      | Min/Max         |
|                                     |                | Bias = ac                                            | 2.65      | 2.5/2.8          | 2.45/2.85    | 2.45/2.85      | V       | Min/Max         |
| Sync tip clamp voltage              | Buffer output  | Bias = ac STC, clamp voltage                         | 295       | 205/410          | 200/415      | 195/420        | mV      | Min/Max         |
|                                     | Monitor output |                                                      | 300       | 200/400          | 195/405      | 190/410        | mV      | Min/Max         |
| Input bias current                  |                | Bias = dc; (–) implies I <sub>B</sub> out of the pin | –1.4      | –3.0             | –3.5         | –3.5           | μA      | Max             |
| Average bias current drift          |                | Bias = dc                                            |           |                  |              | 10             | nA/°C   | Typ             |
| Sync tip clamp bias current         |                | Bias = ac STC, low bias                              | 2.4       | 0.9/3.9          | 0.8/4.0      | 0.7/4.1        | μA      | Min/Max         |
|                                     |                | Bias = ac STC, mid bias                              | 6.2       | 3.9/8.4          | 3.8/8.6      | 3.7/8.7        | μA      | Min/Max         |
|                                     |                | Bias = ac STC, high bias                             | 8.6       | 6/11.2           | 5.8/11.4     | 5.7/11.5       | μA      | Min/Max         |

**ELECTRICAL CHARACTERISTICS,  $V_A = V_{DD} = 5\text{ V}$  (continued)**

$R_L = 150\Omega \parallel 5\text{pF}$  to GND for Monitor Output,  $19\text{k}\Omega \parallel 8\text{pF}$  Load to GND for Buffer Output, SAG pin shorted to Monitor Output Pin, unless otherwise noted.

| PARAMETER                                                          |          | TEST CONDITIONS                                                                                 | TYP      | OVER TEMPERATURE |              |                |      |                 |
|--------------------------------------------------------------------|----------|-------------------------------------------------------------------------------------------------|----------|------------------|--------------|----------------|------|-----------------|
|                                                                    |          |                                                                                                 | +25°C    | +25°C            | 0°C to +70°C | −40°C to +85°C | UNIT | MIN/MAX/<br>TYP |
| INPUT CHARACTERISTICS                                              |          |                                                                                                 |          |                  |              |                |      |                 |
| Input voltage range                                                |          | Bias = dc                                                                                       | 0 to 3.4 |                  |              |                | V    | Typ             |
| Input resistance                                                   |          | Bias = ac bias mode                                                                             | 25       |                  |              |                | kΩ   | Typ             |
|                                                                    |          | Bias = dc, dc + shift, ac STC                                                                   | 3        |                  |              |                | MΩ   | Typ             |
| Input capacitance                                                  |          |                                                                                                 | 1.5      |                  |              |                | pF   | Typ             |
| OUTPUT CHARACTERISTICS: MONITOR OUTPUT                             |          |                                                                                                 |          |                  |              |                |      |                 |
| High output voltage swing                                          |          | R <sub>L</sub> = 150 Ω to 2.5 V                                                                 | 4.8      | 4.65             | 4.6          | 4.6            | V    | Min             |
|                                                                    |          | R <sub>L</sub> = 150 Ω to GND                                                                   | 4.7      | 4.55             | 4.5          | 4.5            | V    | Min             |
|                                                                    |          | R <sub>L</sub> = 75 Ω to 2.5 V                                                                  | 4.7      |                  |              |                | V    | Typ             |
|                                                                    |          | R <sub>L</sub> = 75 Ω to GND                                                                    | 4.6      |                  |              |                | V    | Typ             |
| Low output voltage swing                                           |          | R <sub>L</sub> = 150 Ω to 2.5 V                                                                 | 0.2      | 0.25             | 0.28         | 0.30           | V    | Max             |
|                                                                    |          | R <sub>L</sub> = 150 Ω to GND                                                                   | 0.1      | 0.19             | 0.23         | 0.24           | V    | Max             |
|                                                                    |          | R <sub>L</sub> = 75 Ω to 2.5 V                                                                  | 0.24     |                  |              |                | V    | Typ             |
|                                                                    |          | R <sub>L</sub> = 75 Ω to GND                                                                    | 0.085    |                  |              |                | V    | Typ             |
| Output current                                                     | Sourcing | R <sub>L</sub> = 10 Ω to 2.5 V                                                                  | 110      | 85               | 80           | 75             | mA   | Min             |
|                                                                    | Sinking  |                                                                                                 | 110      | 85               | 80           | 75             | mA   | Min             |
| OUTPUT CHARACTERISTICS: BUFFER OUTPUT                              |          |                                                                                                 |          |                  |              |                |      |                 |
| High output voltage swing<br>(Limited by input range and G = 0 dB) |          | Load = 19 kΩ    8 pF to 2.5 V                                                                   | 3.4      | 3.1              | 3.0          | 3.0            | V    | Min             |
| Low output voltage swing<br>(Limited by input range and G = 0 dB)  |          |                                                                                                 | 0.05     | 0.12             | 0.13         | 0.14           | V    | Max             |
| Output current                                                     | Sourcing | R <sub>L</sub> = 10 Ω to GND                                                                    | 110      | 85               | 80           | 75             | mA   | Min             |
|                                                                    | Sinking  | R <sub>L</sub> = 10 Ω to 2.5 V                                                                  | 110      | 85               | 80           | 75             | mA   | Min             |
| POWER SUPPLY: ANALOG                                               |          |                                                                                                 |          |                  |              |                |      |                 |
| Maximum operating voltage                                          |          | V <sub>A</sub>                                                                                  | 5.0      | 5.5              | 5.5          | 5.5            | V    | Max             |
| Minimum operating voltage                                          |          | V <sub>A</sub>                                                                                  | 5.0      | 2.7              | 2.7          | 2.7            | V    | Min             |
| Maximum quiescent current                                          |          | V <sub>A</sub> , dc + shift mode, V <sub>IN</sub> = 100 mV                                      | 90       | 112              | 115          | 117            | mA   | Max             |
| Minimum quiescent current                                          |          | V <sub>A</sub> , dc + shift mode, V <sub>IN</sub> = 100 mV                                      | 90       | 68               | 65           | 63             | mA   | Min             |
| Power supply rejection (+PSRR)                                     |          | Buffer Output                                                                                   | 46       |                  |              |                | dB   | Typ             |
| POWER SUPPLY: DIGITAL                                              |          |                                                                                                 |          |                  |              |                |      |                 |
| Maximum operating voltage                                          |          | V <sub>DD</sub>                                                                                 | 5.0      | 5.5              | 5.5          | 5.5            | V    | Max             |
| Minimum operating voltage                                          |          | V <sub>DD</sub>                                                                                 | 5.0      | 2.7              | 2.7          | 2.7            | V    | Min             |
| Maximum quiescent current                                          |          | V <sub>DD</sub> , V <sub>IN</sub> = 0 V                                                         | 1        | 2                | 3            | 3              | mA   | Max             |
| Minimum quiescent current                                          |          | V <sub>DD</sub> , V <sub>IN</sub> = 0 V                                                         | 1        | 0.5              | 0.4          | 0.4            | mA   | Min             |
| DIGITAL CHARACTERISTICS <sup>(1)</sup>                             |          |                                                                                                 |          |                  |              |                |      |                 |
| High level input voltage                                           |          | V <sub>IH</sub>                                                                                 | 3.5      |                  |              |                | V    | Typ             |
| Low level input voltage                                            |          | V <sub>IL</sub>                                                                                 | 1.5      |                  |              |                | V    | Typ             |
| DISABLE CHARACTERISTICS: ALL CHANNELS DISABLED                     |          |                                                                                                 |          |                  |              |                |      |                 |
| Quiescent current                                                  |          | All channels disabled                                                                           | 1        |                  |              |                | μA   | Typ             |
| Turn-on time delay (t <sub>ON</sub> )                              |          | Time for I <sub>S</sub> to reach 50% of final value after I <sup>2</sup> C control is initiated | 5        |                  |              |                | μs   | Typ             |
| Turn-on time delay (t <sub>OFF</sub> )                             |          |                                                                                                 | 2        |                  |              |                | μs   | Typ             |

(1) Standard CMOS logic.

**ELECTRICAL CHARACTERISTICS,  $V_A = V_{DD} = 5\text{ V}$  (continued)**

$R_L = 150\Omega \parallel 5\text{pF}$  to GND for Monitor Output,  $19\text{k}\Omega \parallel 8\text{pF}$  Load to GND for Buffer Output, SAG pin shorted to Monitor Output Pin, unless otherwise noted.

| PARAMETER                                                                | TEST CONDITIONS                                                              | TYP      | OVER TEMPERATURE |              |                |      |                 |
|--------------------------------------------------------------------------|------------------------------------------------------------------------------|----------|------------------|--------------|----------------|------|-----------------|
|                                                                          |                                                                              | +25°C    | +25°C            | 0°C to +70°C | −40°C to +85°C | UNIT | MIN/MAX/<br>TYP |
| H/V SYNC CHARACTERISTICS: R <sub>Load</sub> = 1 kΩ To GND <sup>(2)</sup> |                                                                              |          |                  |              |                |      |                 |
| Schmitt trigger adjust pin voltage                                       | Reference for Schmitt trigger                                                | 1.54     | 1.43/1.65        | 1.38/1.7     | 1.35/1.73      | V    | Min/Max         |
| Schmitt trigger threshold range                                          | Allowable range for Schmitt trigger adjust                                   | 0.9 to 2 |                  |              |                | V    | Typ             |
| Schmitt trigger VT+                                                      | Positive-going input voltage threshold relative to Schmitt trigger threshold | 0.25     |                  |              |                | V    | Typ             |
| Schmitt trigger VT−                                                      | Negative-going input voltage threshold relative to Schmitt trigger threshold | −0.3     |                  |              |                | V    | Typ             |
| Schmitt trigger threshold pin input resistance                           | Input resistance into Control pin                                            | 10       |                  |              |                | kΩ   | Typ             |
| H/V Sync input impedance                                                 |                                                                              | 10       |                  |              |                | MΩ   | Typ             |
| H/V Sync high output voltage                                             | 1 kΩ to GND                                                                  | 4.8      | 4.7              | 4.6          | 4.6            | V    | Min             |
| H/V Sync low output voltage                                              | 1 kΩ to GND                                                                  | 0.01     | 0.05             | 0.1          | 0.1            | V    | Max             |
| H/V Sync source current                                                  | 10 Ω to GND                                                                  | 90       | 60               | 55           | 55             | mA   | Min             |
| H/V Sync sink current                                                    | 10 Ω to 5 V                                                                  | 50       | 30               | 27           | 25             | mA   | Min             |
| H/V Delay                                                                | Delay from input to output                                                   | 6.5      |                  |              |                | ns   | Typ             |
| H/V to buffer output skew                                                |                                                                              | 5        |                  |              |                | ns   | Typ             |

(2) Schmitt trigger threshold is defined by  $(VT+ - VT-)/2$ .

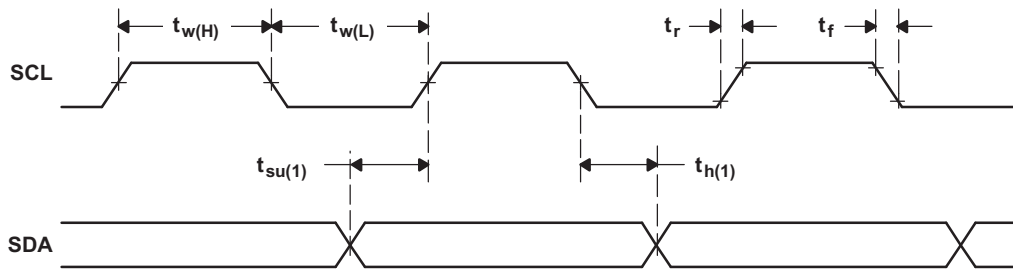
## TIMING REQUIREMENTS FOR I<sup>2</sup>C INTERFACE<sup>(1)(2)</sup>

At V<sub>DD</sub> = 2.7 V to 5 V.

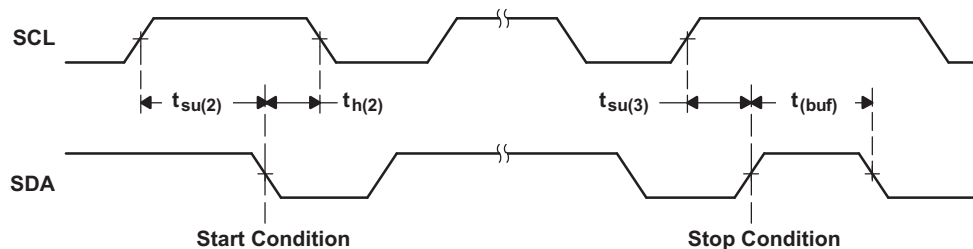
| PARAMETER          |                                                 | STANDARD MODE |      | FAST MODE |     | UNIT |
|--------------------|-------------------------------------------------|---------------|------|-----------|-----|------|
|                    |                                                 | MIN           | MAX  | MIN       | MAX |      |
| f <sub>SCL</sub>   | Clock frequency, SCL                            | 0             | 100  | 0         | 400 | kHz  |
| t <sub>w(H)</sub>  | Pulse duration, SCL high                        | 4             |      | 0.6       |     | μs   |
| t <sub>w(L)</sub>  | Pulse duration, SCL low                         | 4.7           |      | 1.3       |     | μs   |
| t <sub>r</sub>     | Rise time, SCL and SDA                          |               | 1000 |           | 300 | ns   |
| t <sub>f</sub>     | Fall time, SCL and SDA                          |               | 300  |           | 300 | ns   |
| t <sub>su(1)</sub> | Setup time, SDA to SCL                          | 250           |      | 100       |     | ns   |
| t <sub>h(1)</sub>  | Hold time, SCL to SDA                           | 0             |      | 0         |     | ns   |
| t <sub>(buf)</sub> | Bus free time between stop and start conditions | 4.7           |      | 1.3       |     | μs   |
| t <sub>su(2)</sub> | Setup time, SCL to start condition              | 4.7           |      | 0.6       |     | μs   |
| t <sub>h(2)</sub>  | Hold time, start condition to SCL               | 4             |      | 0.6       |     | μs   |
| t <sub>su(3)</sub> | Setup time, SCL to stop condition               | 4             |      | 0.6       |     | μs   |
| C <sub>b</sub>     | Capacitive load for each bus line               |               | 400  |           | 400 | pF   |

(1) The THS7347 I<sup>2</sup>C address = 01011(A1)(A0)(R/W). See the [Applications Information](#) section for more information.

(2) The THS7347 was designed to comply with version 2.1 of the I<sup>2</sup>C specification.

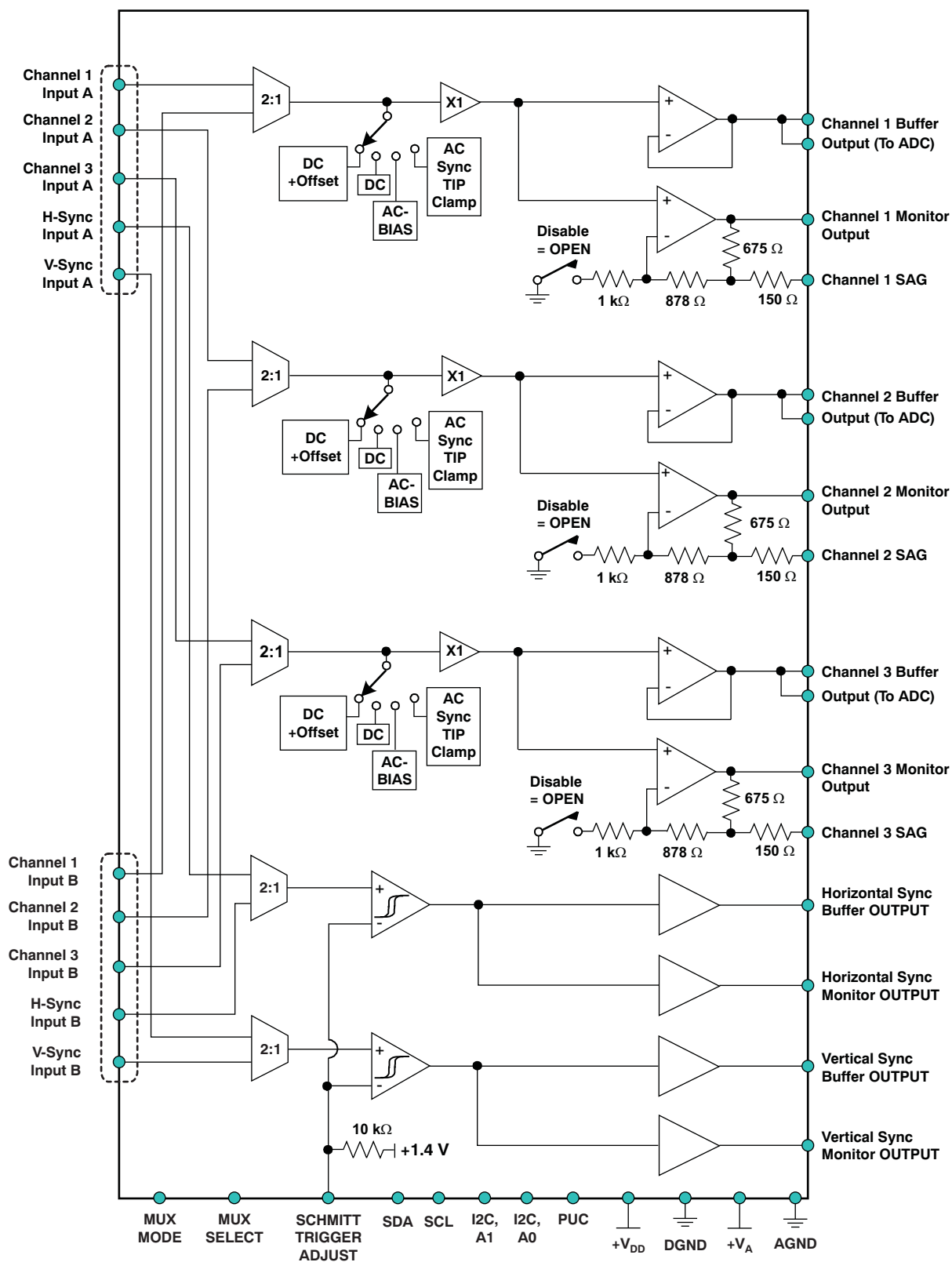


**Figure 1. SCL and SDA Timing**



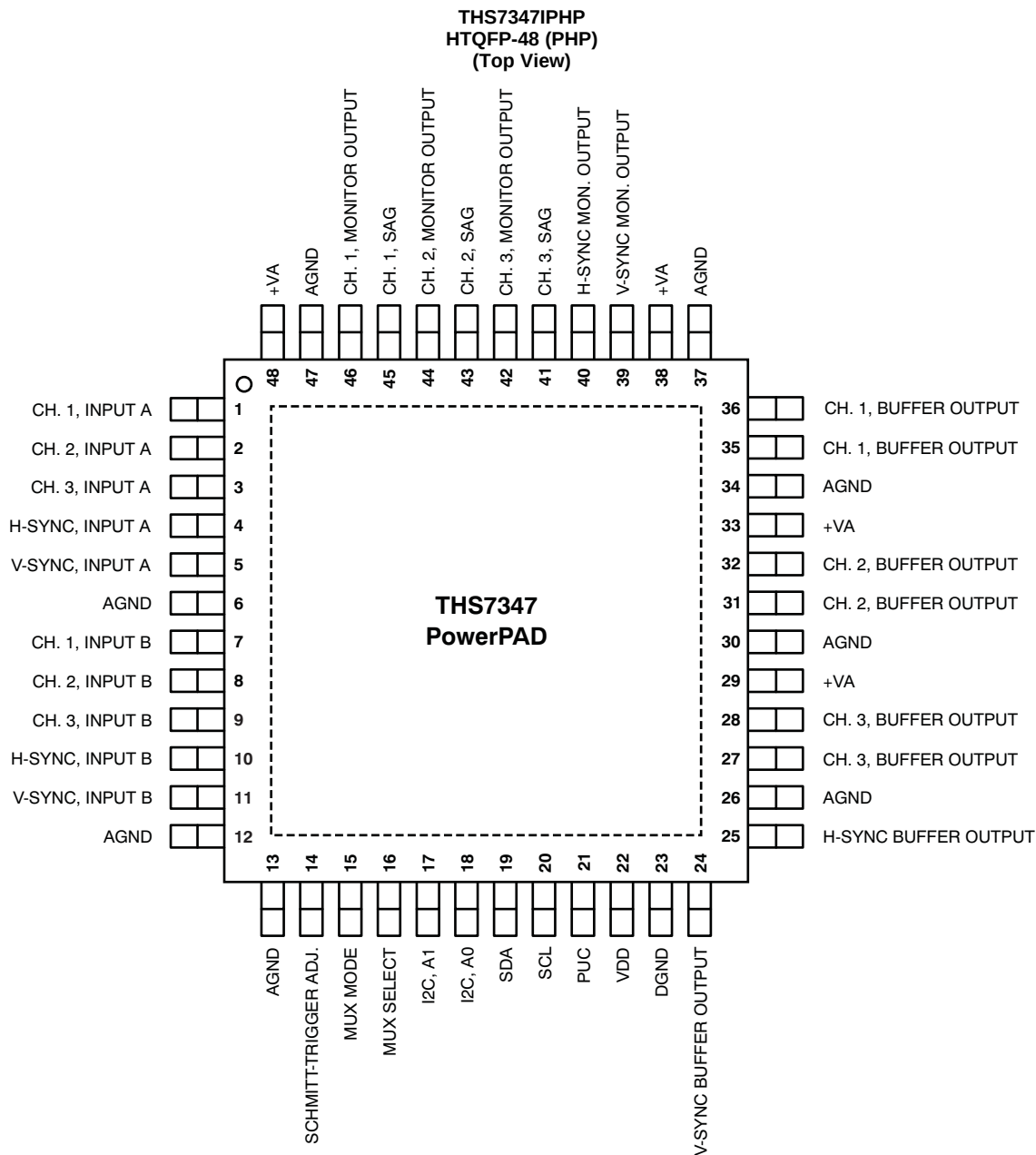
**Figure 2. Start and Stop Conditions**

## FUNCTIONAL BLOCK DIAGRAM



NOTE: The I<sup>2</sup>C address of the THS7347 is 01011(A1)(A0)(R/W).

## PIN CONFIGURATION



## TERMINAL FUNCTIONS

| TERMINAL        |     | I/O | DESCRIPTION                    |
|-----------------|-----|-----|--------------------------------|
| NAME            | NO. |     |                                |
| CH. 1, INPUT A  | 1   | I   | Video Input Channel 1, Input A |
| CH. 2, INPUT A  | 2   | I   | Video Input Channel 2, Input A |
| CH. 3, INPUT A  | 3   | I   | Video Input Channel 3, Input A |
| H-SYNC, INPUT A | 4   | I   | Horizontal Sync, Input A       |
| V-SYNC, INPUT A | 5   | I   | Vertical Sync, Input A         |
| CH. 1, INPUT B  | 7   | I   | Video Input Channel 1, Input B |
| CH. 2, INPUT B  | 8   | I   | Video Input Channel 2, Input B |
| CH. 3, INPUT B  | 9   | I   | Video Input Channel 3, Input B |

**TERMINAL FUNCTIONS (continued)**

| TERMINAL               |                               | I/O | DESCRIPTION                                                                                                                                                                                                                                           |
|------------------------|-------------------------------|-----|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                   | NO.                           |     |                                                                                                                                                                                                                                                       |
| H-SYNC, INPUT B        | 10                            | I   | Horizontal Sync, Input B                                                                                                                                                                                                                              |
| V-SYNC, INPUT B        | 11                            | I   | Vertical Sync, Input B                                                                                                                                                                                                                                |
| I <sup>2</sup> C, A1   | 17                            | I   | I <sup>2</sup> C Slave Address Control Bit A1. Connect to V <sub>DD</sub> for a logic 1 preset value or GND for a logic 0 preset value.                                                                                                               |
| I <sup>2</sup> C, A0   | 18                            | I   | I <sup>2</sup> C Slave Address Control Bit A0. Connect to V <sub>DD</sub> for a logic 1 preset value or GND for a logic 0 preset value.                                                                                                               |
| SDA                    | 19                            | I/O | Serial data line of the I <sup>2</sup> C bus. Pull-up resistor should have a minimum value = 2 kΩ and a maximum value = 19 kΩ. Pull up to V <sub>DD</sub> .                                                                                           |
| SCL                    | 20                            | I   | I <sup>2</sup> C bus clock line. Pull-up resistor should have a minimum value = 2 kΩ and a maximum value = 19 kΩ. Pull up to V <sub>DD</sub> .                                                                                                        |
| PUC                    | 21                            | I   | Power-Up Condition. Connect to GND for all channels disabled upon power-up. Connect to V <sub>DD</sub> (logic high) to set buffer outputs to OFF and monitor outputs ON with ac-bias configuration on Channels 1 to 3 and both H-Sync/V-Sync enabled. |
| MUX MODE               | 15                            | I   | Sets the MUX configuration control. Connect to logic low for MUX Select (pin 16) control of the MUX. Connect to logic high for I <sup>2</sup> C control of the MUX.                                                                                   |
| MUX SELECT             | 16                            | I   | Controls the MUX selection when MUX MODE (pin 15) is set to logic low. Connect to logic low for MUX selector set to Input A. Connect to logic high for MUX selector set to Input B.                                                                   |
| CH. 1, BUFFER OUTPUT   | 35, 36                        | O   | Output Channel 1 from either CH. 1, INPUT A or CH. 1, INPUT B. Connect to ADC/Scalar/Decoder. Both pins should be connected together on the PCB.                                                                                                      |
| CH. 2, BUFFER OUTPUT   | 31, 32                        | O   | Output Channel 2 from either CH. 2, INPUT A or CH. 2, INPUT B. Connect to ADC/Scalar/Decoder. Both pins should be connected together on the PCB.                                                                                                      |
| CH. 3, BUFFER OUTPUT   | 27, 28                        | O   | Output Channel 3 from either CH. 3, INPUT A or CH. 3, INPUT B. Connect to ADC/Scalar/Decoder. Both pins should be connected together on the PCB.                                                                                                      |
| H-SYNC BUFFER OUTPUT   | 25                            | O   | Horizontal Sync Buffer Output. Connect to ADC/Scalar H-sync input.                                                                                                                                                                                    |
| V-SYNC BUFFER OUTPUT   | 24                            | O   | Vertical Sync Buffer Output. Connect to ADC/Scalar V-sync input.                                                                                                                                                                                      |
| CH. 1, SAG             | 45                            | O   | Video Monitor Pass-Through Output Channel 1 SAG Correction pin. If SAG is not used, connect Directly to CH. 1, OUTPUT pin 46.                                                                                                                         |
| CH. 1, MONITOR OUTPUT  | 46                            | O   | Video Monitor Pass-Through Output Channel 1 from either CH. 1, INPUT A or CH. 1, INPUT B.                                                                                                                                                             |
| CH. 2, SAG             | 43                            | O   | Video Monitor Pass-Through Output Channel 2 SAG Correction pin. If SAG is not used, connect Directly to CH. 2, OUTPUT pin 44.                                                                                                                         |
| CH. 2, MONITOR OUTPUT  | 44                            | O   | Video Monitor Pass-Through Output Channel 2 from either CH. 2, INPUT A or CH. 2, INPUT B.                                                                                                                                                             |
| CH. 3, SAG             | 41                            | O   | Video Monitor Pass-Through Output Channel 3 SAG Correction pin. If SAG is not used, connect Directly to CH. 3, OUTPUT pin 42.                                                                                                                         |
| CH. 3, MONITOR OUTPUT  | 42                            | O   | Video Monitor Pass-Through Output Channel 3 from either CH. 3, INPUT A or CH. 3, INPUT B.                                                                                                                                                             |
| H-SYNC MONITOR OUTPUT  | 40                            | O   | Horizontal Sync Monitor Pass-Through Output.                                                                                                                                                                                                          |
| V-SYNC MONITOR OUTPUT  | 39                            | O   | Vertical Sync Monitor Pass-Through Output.                                                                                                                                                                                                            |
| AGND                   | 6, 12, 13, 26, 30, 34, 37, 47 | I   | Ground Reference pin for analog signals. Internally, these pins connect to DGND, although it is recommended to have the AGND and DGND connected to the proper signals for best results.                                                               |
| +V <sub>A</sub>        | 29, 33, 38, 48                | I   | Analog Positive Power Supply Input pins. Connect to 2.7 V to 5 V. Must be equal to or greater than V <sub>DD</sub> .                                                                                                                                  |
| V <sub>DD</sub>        | 22                            | I   | Digital Positive Supply pin for I <sup>2</sup> C circuitry and H-Sync/V-Sync outputs. Connect to 2.7 V to 5 V.                                                                                                                                        |
| DGND                   | 23                            | I   | Digital GND pin for HV circuitry and I <sup>2</sup> C circuitry.                                                                                                                                                                                      |
| Schmitt Trigger Adjust | 14                            | I   | Defaults to 1.45 V (TTL compatible). Connect to external voltage reference to adjust H-Sync/V-Sync input thresholds from 0.9 V to 2 V range.                                                                                                          |

## APPLICATIONS INFORMATION

The THS7347 is targeted for RGB+HV video buffer applications. Although it can be used for numerous other applications, the needs and requirements of the video signal were the most important design parameters of the THS7347. Built on the revolutionary complementary silicon-germanium (SiGe) BiCom3 process, the THS7347 incorporates many features not typically found in integrated video parts while consuming very low power. Each channel configuration is completely independent of the other channels. This architecture allows for any configuration for each channel to be dictated by the end user, rather than the part dictating what the configuration must be—resulting in a highly flexible system.

The THS7347 has the following features:

- I<sup>2</sup>C interface for easy interfacing to the system.
- Single-supply 2.7-V to 5-V operation with low quiescent current of 80 mA at 3.3 V.
- 2:1 input mux.
- Input configuration accepts dc, dc + shift, ac bias, or ac sync-tip clamp selection.
- 500-MHz unity-gain buffer amplifier to drive ADC/Scalar/Decoder.
- Monitor Pass-Through path has an internal fixed gain of 2 V/V (+6 dB) amplifier that can drive two video lines per channel with dc coupling, traditional ac coupling, or SAG-corrected ac coupling.
- While disabled, the Monitor Pass-Through path has a very high output impedance ( $> 500\text{ k}\Omega \parallel 8\text{ pF}$ )
- Power-Up Control (PUC) allows the THS7347 to be fully disabled or have the Monitor Pass-Through function (with ac-bias mode on all channels) enabled upon initial device power-up.
- Mux is controlled by either I<sup>2</sup>C or a general-purpose input/output (GPIO) pin, based on the MUX Mode pin logic.
- H-Sync and V-Sync paths have an externally-adjustable Schmitt trigger threshold
- Disable mode reduces quiescent current to as low as 0.1- $\mu$ A.

## OPERATING VOLTAGE

The THS7347 is designed to operate from 2.7 V to 5 V over a -40°C to +85°C temperature range. The impact on performance over the entire temperature range is negligible because of the implementation of thin film resistors and high-quality, low temperature coefficient capacitors.

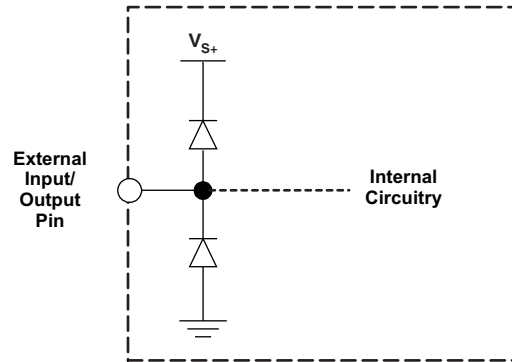
A 0.1- $\mu$ F to 0.01- $\mu$ F capacitor should be placed as close as possible to the power-supply pins. Failure to do so may result in the THS7347 outputs ringing or oscillating. Additionally, a large capacitor, such as 100  $\mu$ F, should be placed on the power-supply line to minimize issues with 50-Hz/60-Hz line frequencies.

## INPUT VOLTAGE

The THS7347 input range allows for an input signal range from ground to approximately ( $V_S + 1.6\text{ V}$ ). However, because of the internal fixed gain of 2 V/V (+6 dB), the output is generally the limiting factor for the allowable linear input range. For example, with a 5-V supply, the linear input range is from GND to 3.4 V. As a result of the gain, the linear output range limits the allowable linear input range from GND to 2.5 V at most.

## INPUT OVERVOLTAGE PROTECTION

The THS7347 is built using a very high-speed complementary bipolar and CMOS process. The internal junction breakdown voltages are relatively low for these very small geometry devices. These breakdowns are reflected in the [Absolute Maximum Ratings](#) table. All input and output device pins are protected with internal ESD protection diodes to the power supplies, as shown in [Figure 3](#).



**Figure 3. Internal ESD Protection**

These diodes provide moderate protection to input overdrive voltages above and below the supplies. The protection diodes can typically support 30 mA of continuous current when overdriven.

## TYPICAL CONFIGURATION

A typical application circuit using the THS7347 as an ac-coupled input video buffer is shown in [Figure 4](#). It shows the THS7347 driving a video ADC (such as the [TVP7000](#)) with 0-dB gain and also driving an output line with 6-dB gain. The Horizontal and Vertical Sync signals are also driven to the ADC and the Monitor Output separately. Although the computer resolution R'G'B'HV signals are shown, these channels can easily be the high-definition video (HD), enhanced-definition (ED), or standard-definition (SD) Y'P'B'P'R' (sometimes labeled Y'U'V' or incorrectly labeled Y'C'B'C'R') channels. These channels could also be S-Video Y'/C' channels and the composite video baseband signal (CVBS). Note that the R'G'B' channels could be professional/broadcast G'B'R' signals or other R'G'B' variations based on the placement of the sync signals that are commonly called R'G'sB' (sync on Green) or R'sG'sB's (sync on all signals).

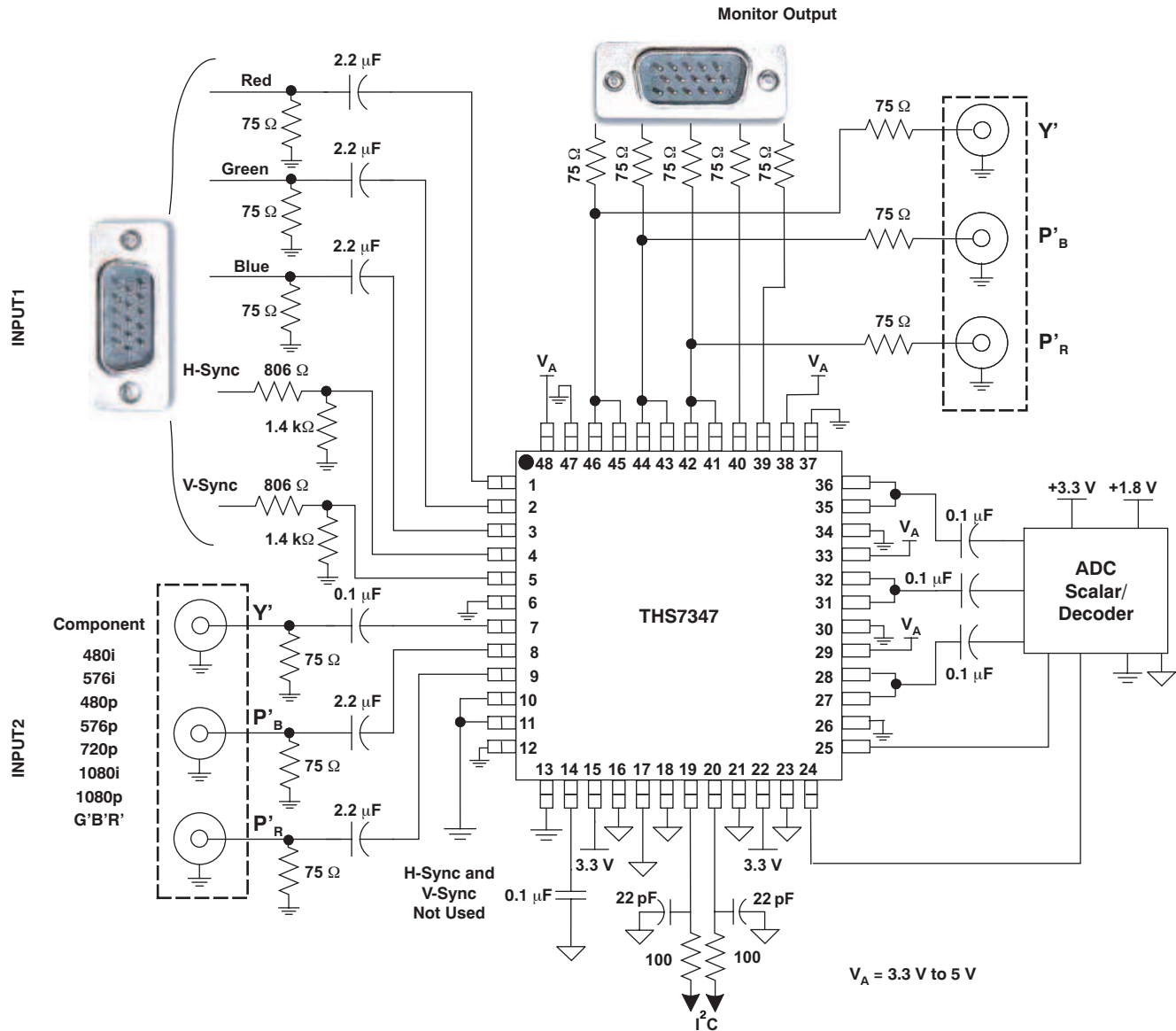
The second set of inputs (B-Channels) shown are connected to another set of inputs. Again, these inputs can be either HD, ED, SD, or R'G'B'/G'B'R' video signals. The THS7347 flexibility allows for virtually any input signal to be driven into the THS7347 regardless of the other set of inputs. Simple control of the I<sup>2</sup>C configures the THS7347 for any conceivable combination. For example, the THS7347 can be configured to have Channel 1 Input connected to input A while Channel 2 and Channel 3 are connected to input B. See the multiple application notes sections explaining the I<sup>2</sup>C interface later in this document for details on configuring these options.

Note that the Y' term is used for the luma channels throughout this document, rather than the more common luminance (Y) term. The reason for this usage is to account for the true definition of luminance as stipulated by the CIE (International Commission on Illumination). Video departs from true luminance because a nonlinear term, gamma, is added to the true RGB signals to form R'G'B' signals. These R'G'B' signals are then utilized to mathematically create luma (Y'). Therefore, true luminance (Y) is not maintained, and thus the difference in terminology arises.

This rationale is also utilized for the chroma (C') term. Chroma is derived from the nonlinear R'G'B' terms and therefore it is also nonlinear. True chrominance (C) is derived from linear RGB, and thus the difference between chroma (C') and chrominance (C) exists. The color difference signals (P'B'/P'R'/U'V') are also referenced this way to denote the nonlinear (gamma-corrected) signals.

R'G'B' (commonly labeled RGB) is also called G'B'R' (again commonly labeled as GBR) in professional video systems. The SMPTE component standard stipulates that the luma information is placed on the first channel, the blue color difference is placed on the second channel, and the red color difference signal is placed on the third channel. This approach is consistent with the Y'P'B'P'R' nomenclature. Because the luma channel (Y') carries the sync information and the green channel (G') also carries the sync information, it makes logical sense that G' be

placed first in the system. Since the blue color difference channel ( $P'_B$ ) is next and the red color difference channel ( $P'_R$ ) is last, then it also makes logical sense to place the B' signal on the second channel and the R' signal on the third channel, respectively. Thus, hardware compatibility is better achieved when using G'B'R' rather than R'G'B'. Note that for many G'B'R' systems, sync is embedded on all three channels; this configuration may not always be the case for all systems.



- Inputs and/or outputs can be ac- or dc-coupled if desired.
- H-Sync and V-Sync input resistance as shown above = 2.2 kΩ, but may be changed to any desired resistance.
- If the Monitor or Buffer PCB trace is > 25 mm, it is recommended to place at least a 10-Ω resistor in series with each signal to reduce PCB parasitic issues

**Figure 4. Typical R'G'B'HV and Y'P'B'P'R AC-Coupled Inputs and DC-Coupled Output Configuration**

## I<sup>2</sup>C INTERFACE NOTES

The I<sup>2</sup>C interface is used to access the internal registers of the THS7347. I<sup>2</sup>C is a two-wire serial interface developed by Philips Semiconductor (see the I<sup>2</sup>C [Bus Specification, Version 2.1, January 2000](#)). The THS7347 was designed in compliance with version 2.1 specifications. The bus consists of a data line (SDA) and a clock line (SCL) with pull-up structures. When the bus is idle, both SDA and SCL lines are pulled high. All the I<sup>2</sup>C-compatible devices connect to the I<sup>2</sup>C bus through open-drain I/O pins, SDA and SCL. A *master* device, usually a microcontroller or a digital signal processor, controls the bus. The master is responsible for generating the SCL signal and device addresses. The master also generates specific conditions that indicate the START and STOP of data transfer. A *slave* device receives and/or transmits data on the bus under control of the master device. The THS7347 works as a slave and supports the standard mode transfer (100 kbps) and fast mode transfer (400 kbps) as defined in the I<sup>2</sup>C Bus Specification. The THS7347 has been tested to be fully functional with the high-speed mode (3.4 Mbps) but it is not specified at this time.

Figure 5 shows the basic I<sup>2</sup>C start and stop access cycles.

The basic access cycle consists of the following:

- A start condition
- A slave address cycle
- Any number of data cycles
- A stop condition

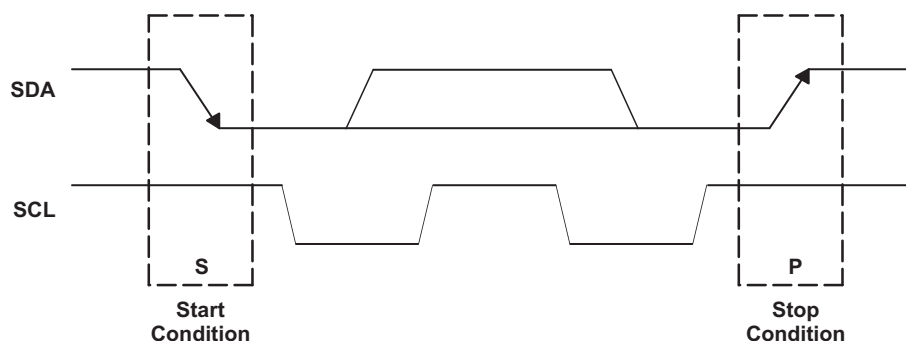


Figure 5. I<sup>2</sup>C Start and Stop Conditions

## GENERAL I<sup>2</sup>C PROTOCOL

- The *master* initiates data transfer by generating a *start condition*. The *start condition* exists when a high-to-low transition occurs on the SDA line while SCL is high, as shown in Figure 5. All I<sup>2</sup>C-compatible devices should recognize a *start condition*.
- The *master* then generates the SCL pulses and transmits the 7-bit address and the *read/write direction bit* R/W on the SDA line. During all transmissions, the master ensures that data is *valid*. A *valid data* condition requires the SDA line to be stable during the entire high period of the clock pulse (see Figure 6). All devices recognize the address sent by the master and compare it to the respective internal fixed addresses. Only the slave device with a matching address generates an *acknowledge* (see Figure 7) by pulling the SDA line low during the entire high period of the ninth SCL cycle. On detecting this acknowledge, the master knows that a communication link with a slave has been established.

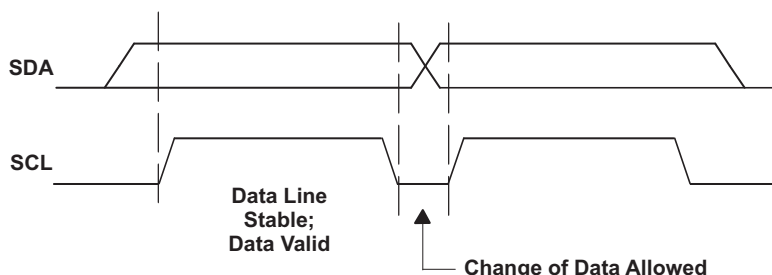


Figure 6. I<sup>2</sup>C Bit Transfer



- 
- The diagram illustrates the timing of an I2C communication. The SCL (Serial Clock Line) signal is a series of pulses numbered 1 to 9. The SDA (Serial Data Line) signal shows a high level during the first 8 pulses, a low level during the 9th pulse (labeled 'Acknowledge'), a high level during the next 8 pulses, and a low level during the 9th pulse (labeled 'Acknowledge'). The diagram is labeled with 'MSB' and 'Slave Address' for the first 8 pulses, and 'Data' and 'Acknowledge' for the last 8 pulses.

- To signal the end of the data transfer, the master generates a *stop condition* by pulling the SDA line from low to high while the SCL line is high (see [Figure 5](#)). This transaction releases the bus and stops the communication link with the addressed slave. All I<sup>2</sup>C-compatible devices must recognize the *stop condition*. Upon the receipt of a stop condition, all devices know that the bus is released, and they wait for a *start condition* followed by a matching address.

During a write cycle, the transmitting device must not drive the SDA signal line during the acknowledge cycle, so that the receiving device may drive the SDA signal low. After each byte transfer following the address byte, the receiving device pulls the SDA line low for one SCL clock cycle. A stop condition is initiated by the transmitting device after the last byte is transferred. Figure 9 and Figure 10 show an example of a write cycle. Note that the THS7347 does not allow multiple write transfers to occur. See the example, **Writing to the THS7347**, in **WRITE AND READ EXAMPLES** for more information.

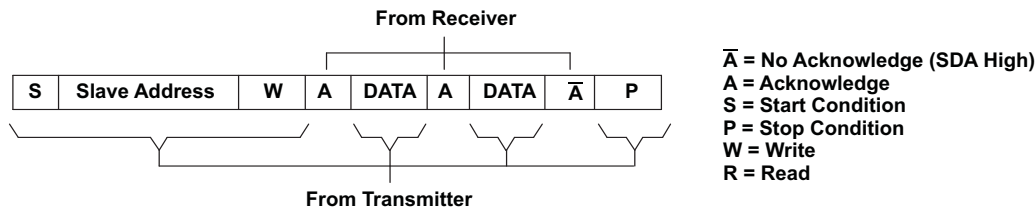


Figure 9. I²C Write Cycle

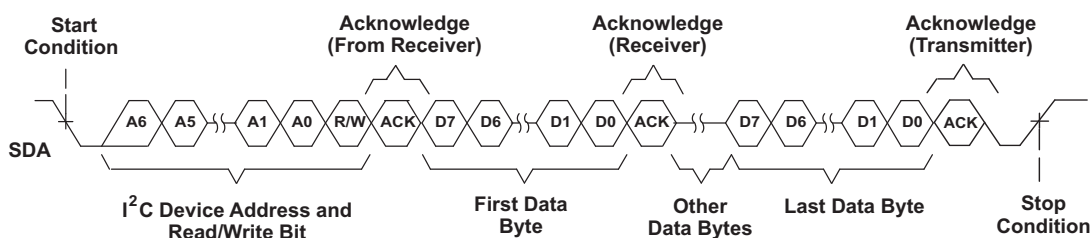


Figure 10. Multiple Byte Write Transfer

During a read cycle, the slave receiver acknowledges the initial address byte if it decodes the address as its address. Following this initial acknowledge by the slave, the master device becomes a receiver and acknowledges data bytes sent by the slave. When the master has received all of the requested data bytes from the slave, the not acknowledge ( $\bar{A}$ ) condition is initiated by the master by keeping the SDA signal high just before it asserts the stop (P) condition. This sequence terminates a read cycle, as shown in Figure 11 and Figure 12. Note that the THS7347 does not allow multiple read transfers to occur. See the example, **Reading from the THS7347**, in **WRITE AND READ EXAMPLES** for more information.

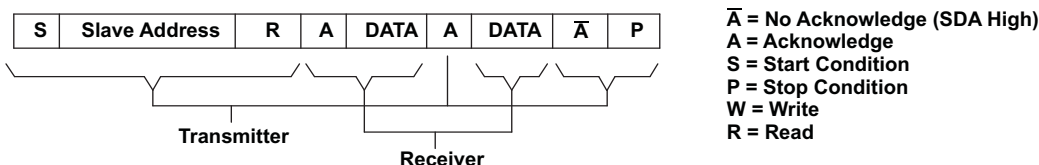


Figure 11. I²C Read Cycle

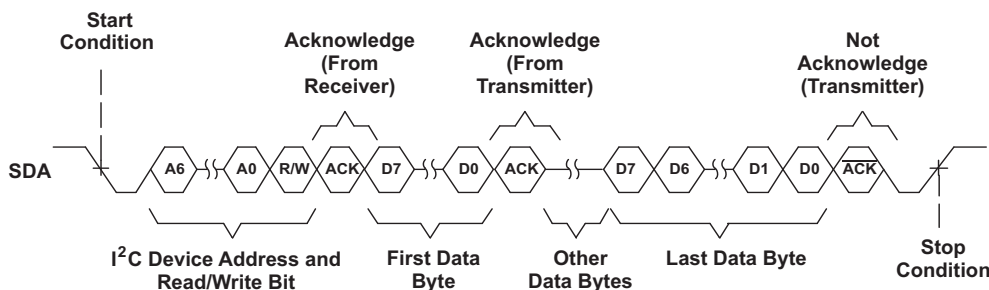


Figure 12. Multiple Byte Read Transfer

## Slave Address

Both the SDA and the SCL must be connected to a positive supply voltage via a pull-up resistor. These resistors should range from 2 k $\Omega$  to 19 k $\Omega$  in order to comply with the I<sup>2</sup>C specification. When the bus is free, both lines are high. The address byte is the first byte received following the START condition from the master device. The first five bits (MSBs) of the address are factory-preset to 01011. The next two bits of the THS7347 address are controlled by the logic levels appearing on the I<sup>2</sup>C, A1 and I<sup>2</sup>C, A0 pins. The I<sup>2</sup>C, A1 and I<sup>2</sup>C, A0 address inputs can be connected to V<sub>DD</sub> for logic 1, GND for logic 0, or actively driven by TTL/CMOS logic levels. The device address is set by the state of these pins and is not latched. Thus, a dynamic address control system could be used to incorporate several devices on the same system. Up to four THS7347 devices can be connected to the same I<sup>2</sup>C bus without requiring additional *glue* logic. [Table 1](#) lists the possible addresses for the THS7347.

**Table 1. THS7347 Slave Addresses**

| FIXED ADDRESS |       |       |       |       | SELECTABLE WITH ADDRESS PINS |            | READ/WRITE BIT |
|---------------|-------|-------|-------|-------|------------------------------|------------|----------------|
| Bit 7 (MSB)   | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 (A1)                   | Bit 1 (A0) | Bit 0 (R/W)    |
| 0             | 1     | 0     | 1     | 1     | 0                            | 0          | 0              |
| 0             | 1     | 0     | 1     | 1     | 0                            | 0          | 1              |
| 0             | 1     | 0     | 1     | 1     | 0                            | 1          | 0              |
| 0             | 1     | 0     | 1     | 1     | 0                            | 1          | 1              |
| 0             | 1     | 0     | 1     | 1     | 1                            | 0          | 0              |
| 0             | 1     | 0     | 1     | 1     | 1                            | 0          | 1              |
| 0             | 1     | 0     | 1     | 1     | 1                            | 1          | 0              |
| 0             | 1     | 0     | 1     | 1     | 1                            | 1          | 1              |

## Channel Selection Register Description (Subaddress) and Power-Up Condition (PUC) Pin

The THS7347 operates using only a single-byte transfer protocol similar to that illustrated in [Figure 9](#) and [Figure 11](#). The internal subaddress registers and the functionality of each are given in [Table 2](#). When writing to the device, it is required to send one byte of data to the corresponding internal subaddress. If control of all three channels is desired, then the master must cycle through all the subaddresses (channels) one at a time; see the example, **Writing to the THS7347** (in [WRITE AND READ EXAMPLES](#)) for the proper procedure of writing to the THS7347.

During a read cycle, the THS7347 sends the data in its selected subaddress (or channel) in a single transfer to the master device requesting the information. See the **Reading from the THS7347** example (in [WRITE AND READ EXAMPLES](#)) for the proper procedure on reading from the THS7347.

On power-up, the THS7347 registers are dictated by the Power-Up Control (PUC) pin. If the PUC pin is tied to GND, the THS7347 powers up in a fully disabled state. If the PUC pin is tied to V<sub>DD</sub>, upon power-up the THS7347 is configured in the following state: ADC buffers disabled, monitor pass-through enabled, and ac-bias on, for all three input channels. It remains in the state dictated by the PUC until a valid write sequence is completed.

**Table 2. THS7347 Channel Selection Register Bit Assignments**

| REGISTER NAME                                        | BIT ADDRESS<br>(b <sub>7</sub> b <sub>6</sub> b <sub>5</sub> ...b <sub>0</sub> ) |
|------------------------------------------------------|----------------------------------------------------------------------------------|
| Channel 1                                            | 0000 0001                                                                        |
| Channel 2                                            | 0000 0010                                                                        |
| Channel 3                                            | 0000 0011                                                                        |
| Channel H Sync, Channel V Sync, and Disable Controls | 0000 0100                                                                        |

## Channel Register Bit Descriptions

Each bit of the subaddress (channel selection) control register as described in [the previous section](#) allows the user to individually control the THS7347 functionality. This process allows the user to control the functionality of each channel independently with regard to the other channels. The bit description for Channel 1 through Channel 3 is shown in [Table 3](#), while the H/V sync channels and the analog channel states are described in [Table 4](#).

**Table 3. THS7347 Channel Register (Channel 1 through Channel 3) Bit Decoder Table.**  
Use with Register Bit Codes (0000 0001), (0000 0010), and (0000 0011)

| BITS             | FUNCTION                     | BIT VALUE(S) | RESULT                                                                    |
|------------------|------------------------------|--------------|---------------------------------------------------------------------------|
| (MSB)<br>7       | Sync-Tip Clamp Filter        | 0            | 500-kHz filter on the STC circuit                                         |
|                  |                              | 1            | 5-MHz filter on the STC circuit                                           |
| 6, 5, 4, 3       | MUX Selection                | 0 0 0 0      | MUX Input A                                                               |
|                  |                              | 0 0 0 1      | MUX Input A                                                               |
|                  |                              | 0 0 1 0      | MUX Input A                                                               |
|                  |                              | 0 0 1 1      | MUX Input A                                                               |
|                  |                              | 0 1 0 0      | MUX Input A                                                               |
|                  |                              | 0 1 0 1      | MUX Input B                                                               |
|                  |                              | 0 1 1 0      | MUX Input B                                                               |
|                  |                              | 0 1 1 1      | MUX Input B                                                               |
|                  |                              | 1 0 0 0      | MUX Input B                                                               |
|                  |                              | 1 0 0 1      | MUX Input B                                                               |
|                  |                              | 1 0 1 0      | Reserved; do not care                                                     |
|                  |                              | 1 0 1 1      | Reserved; do not care                                                     |
|                  |                              | 1 1 0 0      | Reserved; do not care                                                     |
|                  |                              | 1 1 0 1      | Reserved; do not care                                                     |
|                  |                              | 1 1 1 0      | Reserved; do not care                                                     |
|                  |                              | 1 1 1 1      | Reserved; do not care                                                     |
| 2, 1, 0<br>(LSB) | Input Mode<br>+<br>Operation | 0 0 0        | Disables both monitor and buffer paths of the respective channel/register |
|                  |                              | 0 0 1        | Channel Mute                                                              |
|                  |                              | 0 1 0        | Input Mode = dc                                                           |
|                  |                              | 0 1 1        | Input Mode = dc + Shift                                                   |
|                  |                              | 1 0 0        | Input Mode = ac-bias                                                      |
|                  |                              | 1 0 1        | Input Mode = ac-STC with low bias                                         |
|                  |                              | 1 1 0        | Input Mode = ac-STC with mid bias                                         |
|                  |                              | 1 1 1        | Input Mode = ac-STC with high bias                                        |

**Bit 7 (MSB):** Controls the sync-tip clamp filter. Useful only when AC-STC input mode is selected.

**Bits 6, 5, 4, 3:** Selects the Input MUX channel.

**Bits 2, 1, and 0 (LSB):** Configures the channel mode and operation. See [Table 4](#), Bits 6 and 5, for more information with respect to the enable/disable state.

**Table 4. THS7347 Channel Register (H/V Sync Channel + Analog Channels State) Bit Decoder Table.  
Use in Conjunction With Register Bit Code (0000 0100)**

| BIT        | FUNCTION                                                                       | BIT<br>VALUE(S) | RESULT                                                                                |
|------------|--------------------------------------------------------------------------------|-----------------|---------------------------------------------------------------------------------------|
| (MSB)<br>7 | Reserved; Do not care                                                          | X               | Reserved; do not care                                                                 |
| 6          | Monitor Pass-Through Path Disable<br>Mode<br>(Use in Conjunction with Table 3) | 0               | Disables all monitor channels regardless of bits 2:0 of Register 1 through Register 3 |
|            |                                                                                | 1               | Enables monitor channels functions dictated by each programmed register code          |
| 5          | Buffer Path Disable Mode<br>(Use in Conjunction with Table 3)                  | 0               | Disables all buffer channels regardless of bits 2:0 of Register 1 through Register 3  |
|            |                                                                                | 1               | Enables buffer channel functions dictated by each programmed register code            |
| 4, 3       | Vertical Sync Channel MUX Selection                                            | 0 0             | MUX Input A                                                                           |
|            |                                                                                | 0 1             | MUX Input B                                                                           |
|            |                                                                                | 1 0             | Reserved; do not care                                                                 |
|            |                                                                                | 1 1             | Reserved; do not care                                                                 |
| 2, 1       | Horizontal Sync Channel MUX Selection                                          | 0 0             | MUX Input A                                                                           |
|            |                                                                                | 0 1             | MUX Input B                                                                           |
|            |                                                                                | 1 0             | Reserved; do not care                                                                 |
|            |                                                                                | 1 1             | Reserved; do not care                                                                 |
| 0<br>(LSB) | H/V Sync Paths Disable Mode                                                    | 0               | Disable H-Sync and V-Sync Channels                                                    |
|            |                                                                                | 1               | Enable H-Sync and V-Sync Channels                                                     |

**Bit (MSB) 7:** Reserved; do not care.

**Bit 6:** Master Monitor Path Disable. Disables all monitor channels regardless of what is programmed into each register channel (1 to 3).

**Bit 5:** Master Buffer Path Disable. Disables all buffer channels regardless of what is programmed into each register channel (1 to 3).

**Bits 4, 3:** Selects the Input MUX channel for the Vertical Sync.

**Bits 2, 1:** Selects the Input MUX channel for the Horizontal Sync.

**Bit 0 (LSB):** Enables or disables the H-Sync and V-Sync Channels.

## WRITE AND READ EXAMPLES

These examples illustrate the proper way to write to and read from the THS7347.

### WRITING TO THE THS7347

An I<sup>2</sup>C master initiates a write operation to the THS7347 by generating a start condition (S) followed by the THS7347 I<sup>2</sup>C address, in MSB-first order, followed by a '0' to indicate a write cycle. After receiving an acknowledge from the THS7347, the master presents the subaddress (channel) it wants to write, consisting of one byte of data, MSB first. The THS7347 acknowledges the byte after completion of the transfer. Finally, the master presents the data it wants to write to the register (channel) and the THS7347 acknowledges the byte. The I<sup>2</sup>C master then terminates the write operation by generating a stop condition (P). Note that the THS7347 does not support multi-byte transfers. To write to all three channels (or registers), this procedure must be repeated for each register, one series at a time (that is, repeat steps 1 through 8 for each channel).

|                                 |   |  |  |  |  |  |  |  |
|---------------------------------|---|--|--|--|--|--|--|--|
| <b>Step 1</b>                   | 0 |  |  |  |  |  |  |  |
| I <sup>2</sup> C Start (Master) | S |  |  |  |  |  |  |  |

|                                           |   |   |   |   |   |   |   |   |
|-------------------------------------------|---|---|---|---|---|---|---|---|
| <b>Step 2</b>                             | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| I <sup>2</sup> C General Address (Master) | 0 | 1 | 0 | 1 | 1 | X | X | 0 |

Where each X logic state is defined by I<sup>2</sup>C-A1 and I<sup>2</sup>C-A0 pins being tied to either V<sub>DD</sub> or GND.

|                                      |   |  |  |  |  |  |  |  |
|--------------------------------------|---|--|--|--|--|--|--|--|
| <b>Step 3</b>                        | 9 |  |  |  |  |  |  |  |
| I <sup>2</sup> C Acknowledge (Slave) | A |  |  |  |  |  |  |  |

|                                                 |   |   |   |   |   |      |      |      |
|-------------------------------------------------|---|---|---|---|---|------|------|------|
| <b>Step 4</b>                                   | 7 | 6 | 5 | 4 | 3 | 2    | 1    | 0    |
| I <sup>2</sup> C Write Channel Address (Master) | 0 | 0 | 0 | 0 | 0 | Addr | Addr | Addr |

Where *Addr* is determined by the values shown in [Table 2](#).

|                                      |   |  |  |  |  |  |  |  |
|--------------------------------------|---|--|--|--|--|--|--|--|
| <b>Step 5</b>                        | 9 |  |  |  |  |  |  |  |
| I <sup>2</sup> C Acknowledge (Slave) | A |  |  |  |  |  |  |  |

|                                      |      |      |      |      |      |      |      |      |
|--------------------------------------|------|------|------|------|------|------|------|------|
| <b>Step 6</b>                        | 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
| I <sup>2</sup> C Write Data (Master) | Data | Data | Data | Data | Data | Data | Data | Data |

Where *Data* is determined by the values shown in [Table 3](#).

|                                      |   |  |  |  |  |  |  |  |
|--------------------------------------|---|--|--|--|--|--|--|--|
| <b>Step 7</b>                        | 9 |  |  |  |  |  |  |  |
| I <sup>2</sup> C Acknowledge (Slave) | A |  |  |  |  |  |  |  |

|                                |   |  |  |  |  |  |  |  |
|--------------------------------|---|--|--|--|--|--|--|--|
| <b>Step 8</b>                  | 0 |  |  |  |  |  |  |  |
| I <sup>2</sup> C Stop (Master) | P |  |  |  |  |  |  |  |

## READING FROM THE THS7347

The read operation consists of two phases. The first phase is the address phase. In this phase, an I<sup>2</sup>C master initiates a write operation to the THS7347 by generating a start condition (S) followed by the THS7347 I<sup>2</sup>C address, in MSB-first order, followed by a '0' to indicate a write cycle. After receiving an acknowledge from the THS7347, the master presents the subaddress (channel) of the register it wants to read. After the cycle is acknowledged (A), the master terminates the cycle immediately by generating a stop condition (P).

The second phase is the data phase. In this phase, an I<sup>2</sup>C master initiates a read operation to the THS7347 by generating a start condition followed by the THS7347 I<sup>2</sup>C address, in MSB-first order, followed by a '1' to indicate a read cycle. After an acknowledge from the THS7347, the I<sup>2</sup>C master receives one byte of data from the THS7347. After the data byte has been transferred from the THS7347 to the master, the master generates a not-acknowledge ( $\bar{A}$ ) followed by a stop. As with the Write function, to read all channels, steps 1 through 11 must be repeated for each channel desired.

### THS7347 Read Phase 1:

|                                 |   |
|---------------------------------|---|
| <b>Step 1</b>                   | 0 |
| I <sup>2</sup> C Start (Master) | S |

|                                           |   |   |   |   |   |   |   |   |
|-------------------------------------------|---|---|---|---|---|---|---|---|
| <b>Step 2</b>                             | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| I <sup>2</sup> C General Address (Master) | 0 | 1 | 0 | 1 | 1 | X | X | 0 |

Where each X logic state is defined by I<sup>2</sup>C-A1 and I<sup>2</sup>C-A0 pins being tied to either V<sub>DD</sub> or GND.

|                                      |   |
|--------------------------------------|---|
| <b>Step 3</b>                        | 9 |
| I <sup>2</sup> C Acknowledge (Slave) | A |

|                                                |   |   |   |   |   |      |      |      |
|------------------------------------------------|---|---|---|---|---|------|------|------|
| <b>Step 4</b>                                  | 7 | 6 | 5 | 4 | 3 | 2    | 1    | 0    |
| I <sup>2</sup> C Read Channel Address (Master) | 0 | 0 | 0 | 0 | 0 | Addr | Addr | Addr |

Where *Addr* is determined by the values shown in [Table 2](#).

|                                      |   |
|--------------------------------------|---|
| <b>Step 5</b>                        | 9 |
| I <sup>2</sup> C Acknowledge (Slave) | A |

|                                 |   |
|---------------------------------|---|
| <b>Step 6</b>                   | 0 |
| I <sup>2</sup> C Start (Master) | P |

**THS7347 Read Phase 2:**

|                                 |   |
|---------------------------------|---|
| <b>Step 7</b>                   | 0 |
| I <sup>2</sup> C Start (Master) | S |

|                                           |   |   |   |   |   |   |   |   |
|-------------------------------------------|---|---|---|---|---|---|---|---|
| <b>Step 8</b>                             | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| I <sup>2</sup> C General Address (Master) | 0 | 1 | 0 | 1 | 1 | X | X | 1 |

Where each X Logic state is defined by I<sup>2</sup>C-A1 and I<sup>2</sup>C-A0 pins being tied to either V<sub>DD</sub> or GND.

|                                      |   |
|--------------------------------------|---|
| <b>Step 9</b>                        | 9 |
| I <sup>2</sup> C Acknowledge (Slave) | A |

|                                    |      |      |      |      |      |      |      |      |
|------------------------------------|------|------|------|------|------|------|------|------|
| <b>Step 10</b>                     | 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
| I <sup>2</sup> C Read Data (Slave) | Data | Data | Data | Data | Data | Data | Data | Data |

Where *Data* is determined by the logic values contained in the Channel Register.

|                                           |           |
|-------------------------------------------|-----------|
| <b>Step 11</b>                            | 9         |
| I <sup>2</sup> C Not-Acknowledge (Master) | $\bar{A}$ |

|                                |   |
|--------------------------------|---|
| <b>Step 12</b>                 | 0 |
| I <sup>2</sup> C Stop (Master) | P |

## REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision A (September 2008) to Revision B                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | Page |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| <ul style="list-style-type: none"> <li>Changed first DC Performance, <i>Bias output voltage</i>, <i>Buffer output</i> parameter row +25°C, 0°C to +70°C, and –40°C to +85°C specifications in 3.3-V Electrical Characteristics table ..... 3</li> <li>Changed first DC Performance, <i>Bias output voltage</i>, <i>Monitor output</i> parameter row +25°C, 0°C to +70°C, and –40°C to +85°C specifications in 3.3-V Electrical Characteristics table ..... 3</li> <li>Changed DC Performance, <i>Sync tip clamp voltage</i>, <i>Buffer output</i> parameter +25°C, 0°C to +70°C, and –40°C to +85°C specifications in 3.3-V Electrical Characteristics table ..... 3</li> <li>Changed first DC Performance, <i>Bias output voltage</i>, <i>Buffer output</i> parameter row +25°C, 0°C to +70°C, and –40°C to +85°C specifications in 5-V Electrical Characteristics table ..... 6</li> <li>Changed first DC Performance, <i>Bias output voltage</i>, <i>Monitor output</i> parameter row +25°C, 0°C to +70°C, and –40°C to +85°C specifications in 5-V Electrical Characteristics table ..... 6</li> <li>Changed DC Performance, <i>Sync tip clamp voltage</i>, <i>Buffer output</i> parameter +25°C, 0°C to +70°C, and –40°C to +85°C specifications in 5-V Electrical Characteristics table ..... 6</li> </ul> |      |
| Changes from Original (May 2007) to Revision A                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | Page |
| <ul style="list-style-type: none"> <li>Added <i>Digital Characteristics</i> section to 3.3-V Electrical Characteristics table ..... 3</li> <li>Added <i>Digital Characteristics</i> section to 5-V Electrical Characteristics table ..... 6</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |      |

## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier   | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|------------------|-------------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">THS7347IPHP</a>  | Active        | Production           | HTQFP (PHP)   48 | 250   JEDEC TRAY (10+1) | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | THS7347             |
| THS7347IPHP.B                | Active        | Production           | HTQFP (PHP)   48 | 250   JEDEC TRAY (10+1) | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | THS7347             |
| THS7347IPHPG4                | Active        | Production           | HTQFP (PHP)   48 | 250   JEDEC TRAY (10+1) | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | THS7347             |
| <a href="#">THS7347IPHPR</a> | Active        | Production           | HTQFP (PHP)   48 | 1000   LARGE T&R        | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | THS7347             |
| THS7347IPHPR.B               | Active        | Production           | HTQFP (PHP)   48 | 1000   LARGE T&R        | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | THS7347             |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

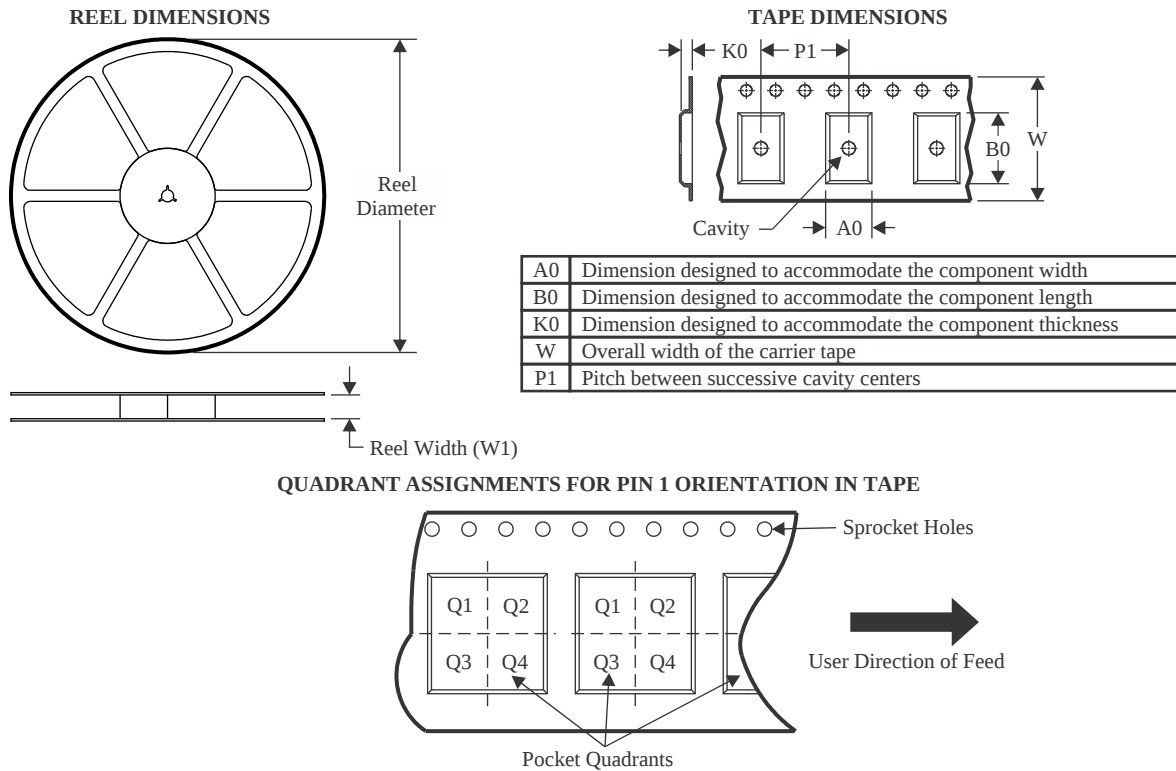
<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

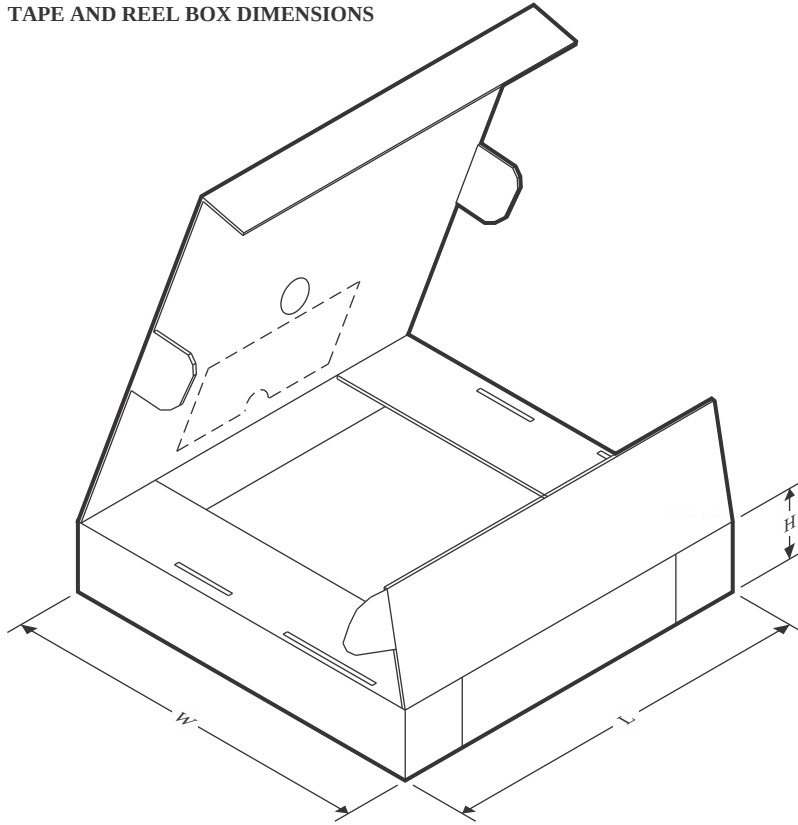
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| THS7347IPHPR | HTQFP        | PHP             | 48   | 1000 | 330.0              | 16.4               | 9.6     | 9.6     | 1.5     | 12.0    | 16.0   | Q2            |

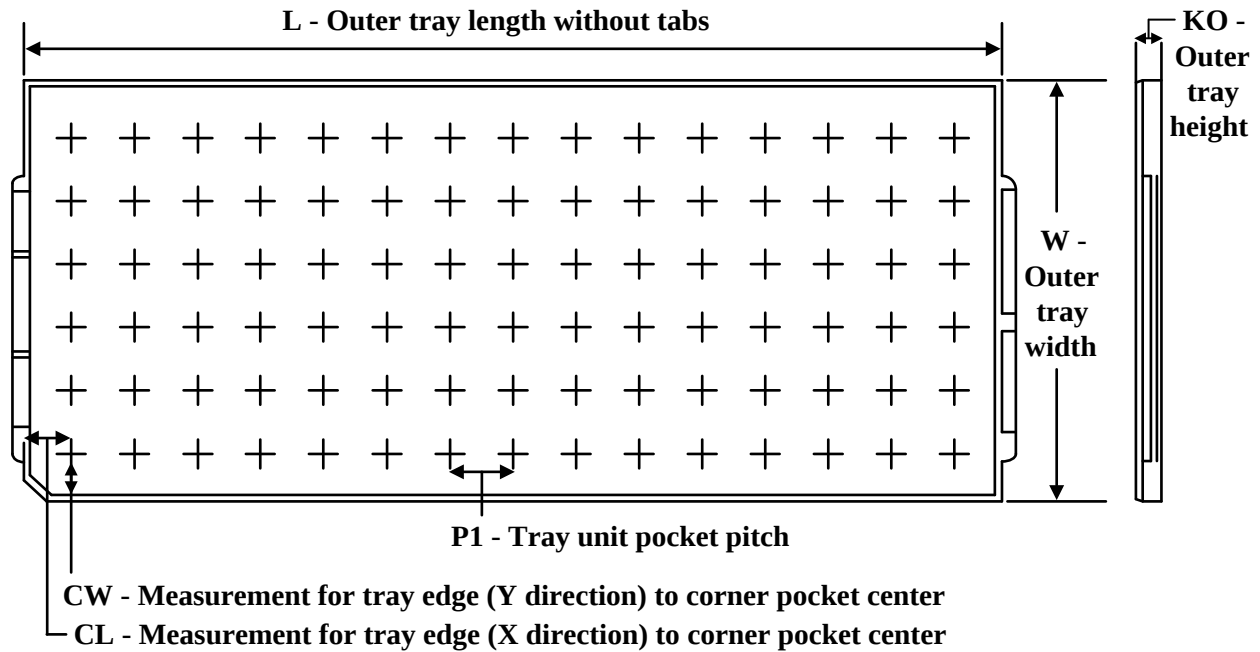
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| THS7347IPHPR | HTQFP        | PHP             | 48   | 1000 | 350.0       | 350.0      | 43.0        |

## TRAY



Chamfer on Tray corner indicates Pin 1 orientation of packed units.

\*All dimensions are nominal

| Device        | Package Name | Package Type | Pins | SPQ | Unit array matrix | Max temperature (°C) | L (mm) | W (mm) | K0 (µm) | P1 (mm) | CL (mm) | CW (mm) |
|---------------|--------------|--------------|------|-----|-------------------|----------------------|--------|--------|---------|---------|---------|---------|
| THS7347IPHP   | PHP          | HTQFP        | 48   | 250 | 10 x 25           | 150                  | 315    | 135.9  | 7620    | 12.2    | 11.1    | 11.25   |
| THS7347IPHP.B | PHP          | HTQFP        | 48   | 250 | 10 x 25           | 150                  | 315    | 135.9  | 7620    | 12.2    | 11.1    | 11.25   |
| THS7347IPHPG4 | PHP          | HTQFP        | 48   | 250 | 10 x 25           | 150                  | 315    | 135.9  | 7620    | 12.2    | 11.1    | 11.25   |

## GENERIC PACKAGE VIEW

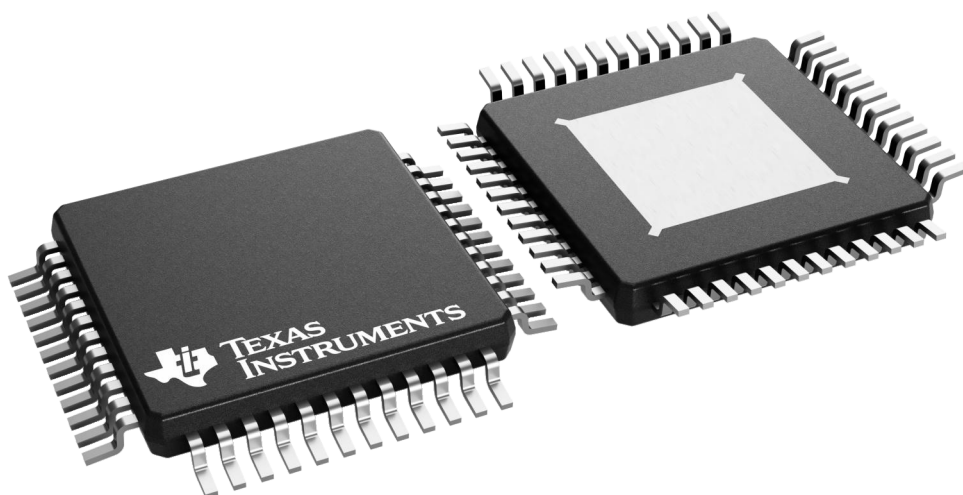
**PHP 48**

**TQFP - 1.2 mm max height**

7 x 7, 0.5 mm pitch

QUAD FLATPACK

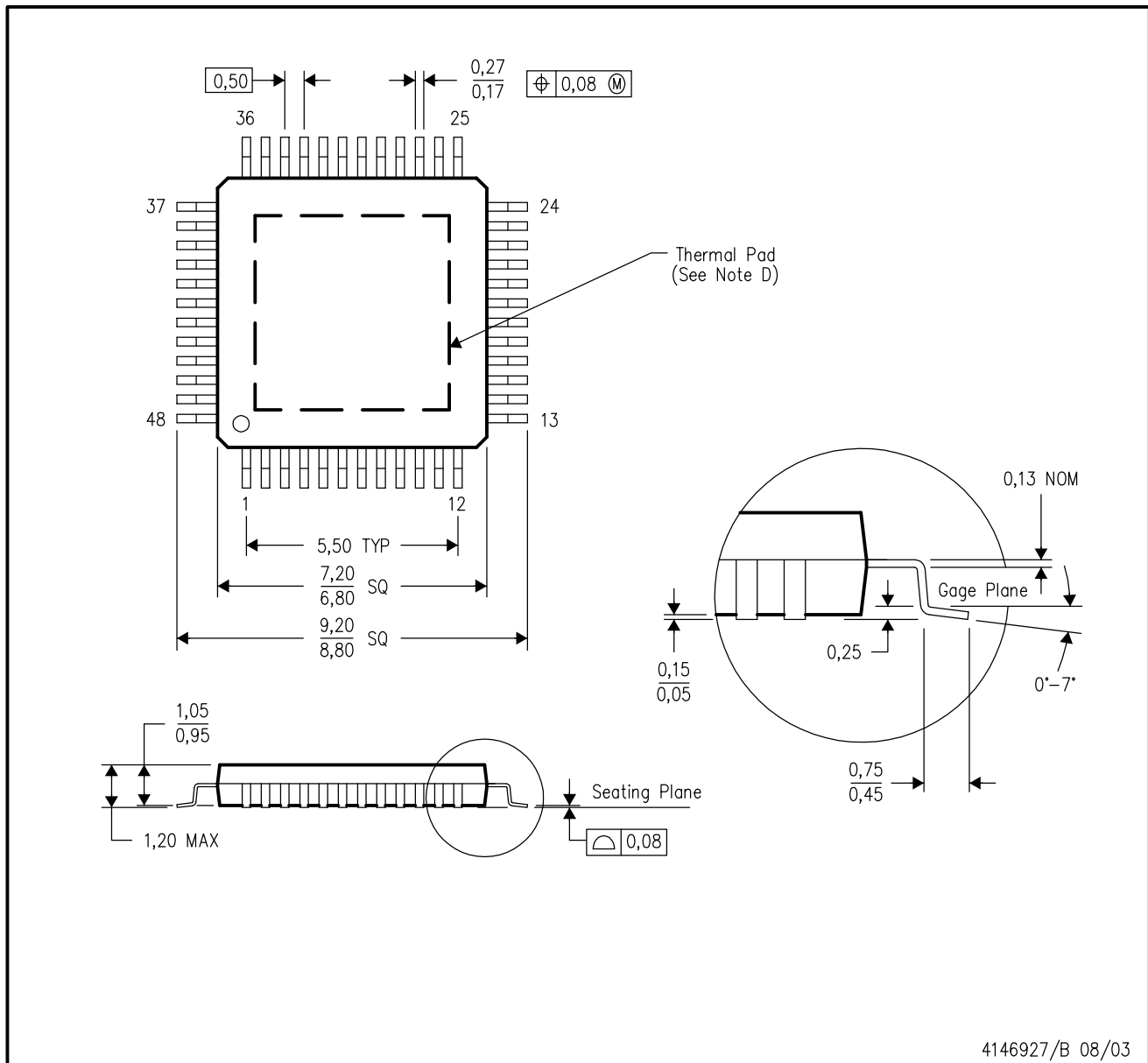
This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4226443/A

PHP (S-PQFP-G48)

PowerPAD™ PLASTIC QUAD FLATPACK



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion
  - D. This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 for information regarding recommended board layout. This document is available at [www.ti.com](http://www.ti.com) <<http://www.ti.com>>.
  - E. Falls within JEDEC MS-026

## THERMAL PAD MECHANICAL DATA

PHP (S-PQFP-G48)

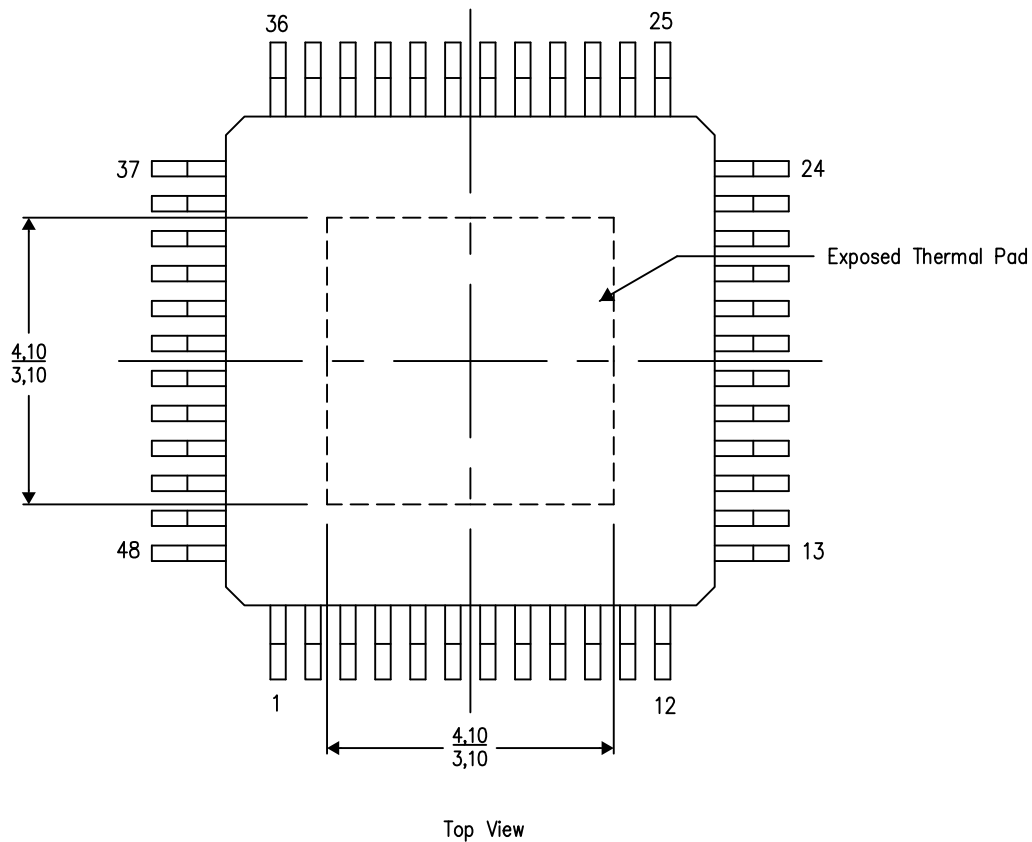
PowerPAD™ PLASTIC QUAD FLATPACK

### THERMAL INFORMATION

This PowerPAD™ package incorporates an exposed thermal pad that is designed to be attached to a printed circuit board (PCB). The thermal pad must be soldered directly to the PCB. After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For additional information on the PowerPAD package and how to take advantage of its heat dissipating abilities, refer to Technical Brief, PowerPAD Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 and Application Brief, PowerPAD Made Easy, Texas Instruments Literature No. SLMA004. Both documents are available at [www.ti.com](http://www.ti.com).

The exposed thermal pad dimensions for this package are shown in the following illustration.

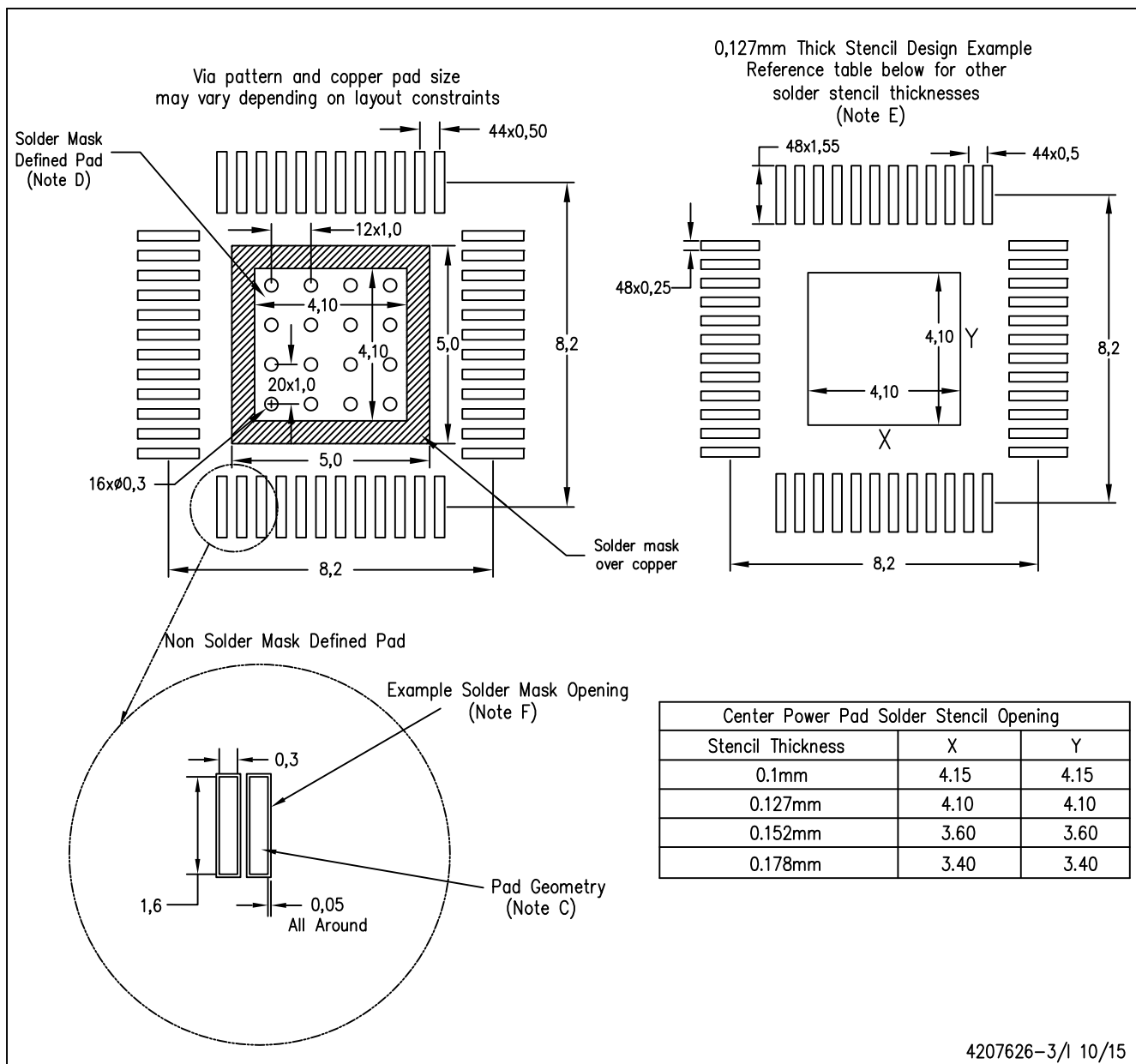


Exposed Thermal Pad Dimensions

4206329-3/P 03/15

NOTE: A. All linear dimensions are in millimeters

PowerPAD is a trademark of Texas Instruments



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002, SLMA004, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at [www.ti.com](http://www.ti.com) <<http://www.ti.com>>.
  - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
  - F. Customers should contact their board fabrication site for recommended solder mask tolerances and via tenting options for vias placed in the thermal pad.

PowerPAD is a trademark of Texas Instruments

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2025, Texas Instruments Incorporated